

# ON Semiconductor

## Is Now

The logo for onsemi, featuring the word "onsemi" in a dark teal, lowercase, sans-serif font. The letter "i" is stylized with a white dot and a teal vertical bar. A small orange triangle is positioned above the top right of the "i". A trademark symbol (TM) is located to the right of the logo.

To learn more about onsemi™, please visit our website at  
[www.onsemi.com](http://www.onsemi.com)

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# NCP1070, NCP1071, NCP1072, NCP1075, NCP1076, NCP1077



ON Semiconductor®

[www.onsemi.com](http://www.onsemi.com)

## High-Voltage Switcher for Low Power Offline SMPS

The NCP107x products integrate a fixed frequency current mode controller with a 700 V MOSFET. Available in a PDIP-7 or SOT-223 package, the NCP107x offer a high level of integration, including soft-start, frequency-jittering, short-circuit protection, skip-cycle, a maximum peak current set point, ramp compensation, and a Dynamic Self-Supply (eliminating the need for an auxiliary winding).

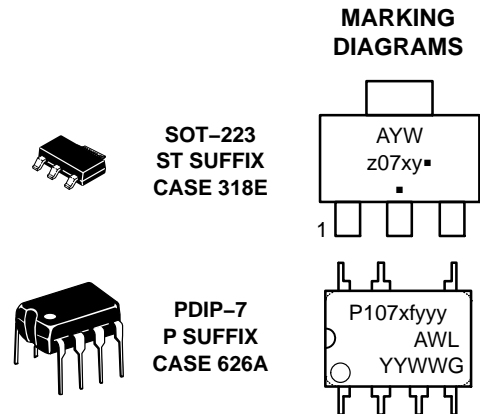
Unlike other monolithic solutions, the NCP107x is quiet by nature: during nominal load operation, the part switches at one of the available frequencies (65, 100 or 130 kHz). When the output power demand diminishes, the IC automatically enters frequency foldback mode and provides excellent efficiency at light loads. When the power demand reduces further, it enters into a skip mode to reduce the standby consumption down to a no load condition.

Protection features include: a timer to detect an overload or a short-circuit event, Overvoltage Protection with auto-recovery and AC input line voltage detection.

For improved standby performance, the connection of an auxiliary winding stops the DSS operation and helps to reduce input power consumption below 50 mW at high line.

### Features

- Built-in 700 V MOSFET with  $R_{DS(on)}$  of 4.7  $\Omega$  (NCP1076/77) / 11  $\Omega$  (NCP1072/75) / 22  $\Omega$  (NCP1070/71)
- Large Creepage Distance Between High-voltage Pins
- Current-Mode Fixed Frequency Operation – 65 / 100 / 130 kHz
- Peak Current: NCP1070/72 with 250 mA, NCP1071 with 350 mA, NCP1075 with 450 mA, NCP1076 with 650 mA and NCP1077 with 800 mA
- Fixed Ramp Compensation
- Skip-Cycle Operation at Low Peak Currents Only: No Acoustic Noise!
- Dynamic Self-Supply: No Need for an Auxiliary Winding
- Internal 1 ms Soft-Start
- Auto-Recovery Output Short Circuit Protection with Timer-Based Detection
- Auto-Recovery Overvoltage Protection with Auxiliary Winding Operation
- Frequency Jittering for Better EMI Signature, Including Frequency Foldback Mode



- Z = 1 for Std product; V for Automotive
- x = Current Limit (0, 1, 2, 5, 6 or 7)
- y = Oscillator Frequency  
A (65 kHz), B (100 kHz), C (130 kHz)
- yyy = 065, 100, 130
- f = OFF phase in fault mode  
P (420 ms), B (210 ms)
- A = Assembly Location
- WL = Wafer Lot
- Y, YY = Year
- W, WW = Work Week
- G or ■ = Pb-Free Package

### ORDERING INFORMATION

See detailed ordering and shipping information on page 28 of this data sheet.

- No Load Input Consumption < 50 mW
- Frequency Foldback to Improve Efficiency at Light Load
- Internal Temperature Shutdown
- These are Pb-Free Devices

### Typical Applications

- Auxiliary / Standby Isolated Power Supplies White Goods / Smart Meter / E-Meter

# NCP1070, NCP1071, NCP1072, NCP1075, NCP1076, NCP1077

## PIN CONNECTIONS

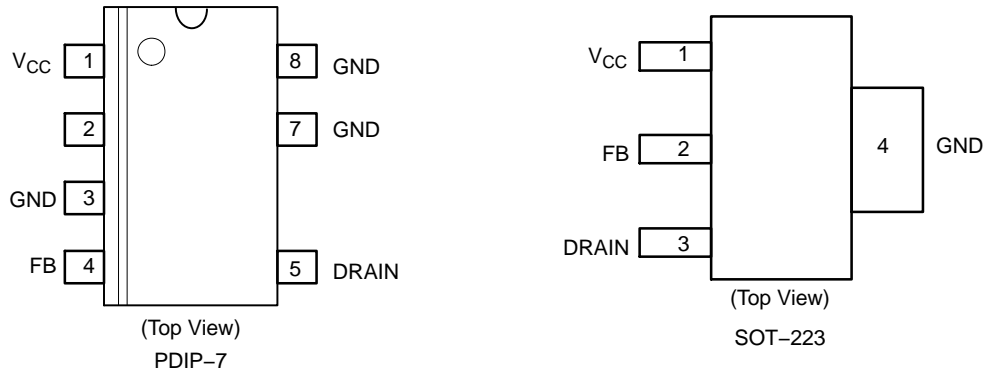


Figure 1. Pin Connections

### INDICATIVE MAXIMUM OUTPUT POWER

	$R_{DS(on)} - I_{PK}$	230 Vac	85–265 Vac
NCP1070 / 1071	22 $\Omega$ – 350 mA	14 W	7.75 W
NCP1072 / 1075	11 $\Omega$ – 450 mA	19 W	10 W
NCP1076 / 1077	4.7 $\Omega$ – 800 mA	25 W	15 W

NOTE: Informative values only, with  $T_{amb} = 50^{\circ}\text{C}$ ,  $F_{SW} = 65 \text{ kHz}$ , Self supply via Auxiliary winding and circuit mounted on minimum copper area as recommended.

### QUICK SELECTION TABLE

	NCP1070			NCP1071			NCP1072			NCP1075			NCP1076			NCP1077		
$R_{DS(on)}$ ( $\Omega$ )	22						11						4.7					
$I_{peak}$ (mA)	250			350			250			450			650			800		
Freq (kHz)	65	100	130	65	100	130	65	100	130*	65	100	130	65	100	130	65	100	130

\*130 kHz on demand only

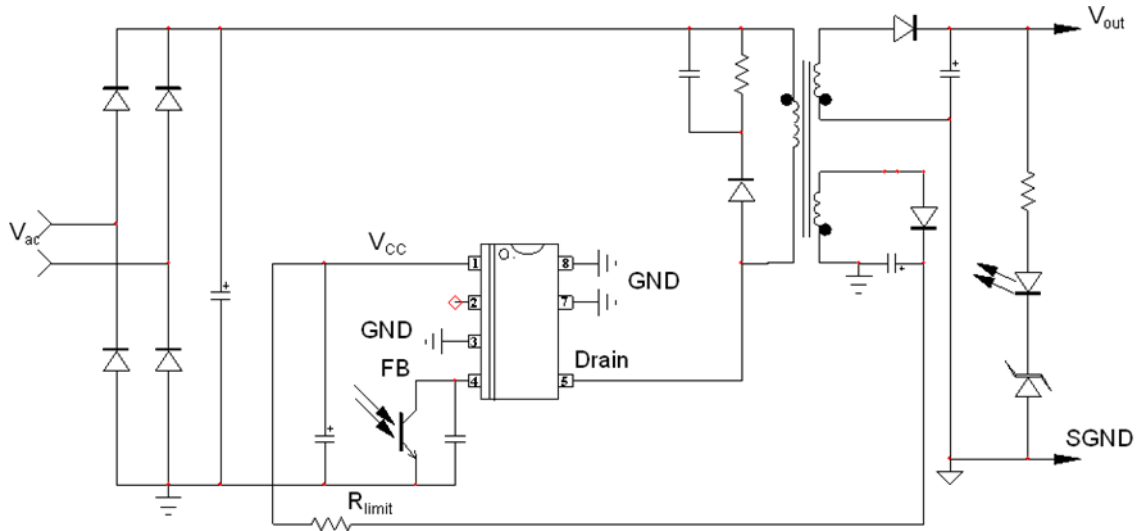


Figure 2. Typical Application Example

PIN FUNCTION DESCRIPTION

Pin N°	Pin Name	Function	Pin Description
1	V <sub>CC</sub>	Powers the internal circuitry	This pin is connected to an external capacitor. The V <sub>CC</sub> includes an active shunt which serves as an auto-recovery over voltage protection.
2	NC		
3	GND	The IC Ground	
4	FB	Feedback signal input	By connecting an opto-coupler to this pin, the peak current set point is adjusted accordingly to the output power demand.
5	Drain	Drain connection	The internal drain MOSFET connection
6			This un-connected pin ensures adequate creepage distance
7	GND	The IC Ground	
8	GND	The IC Ground	

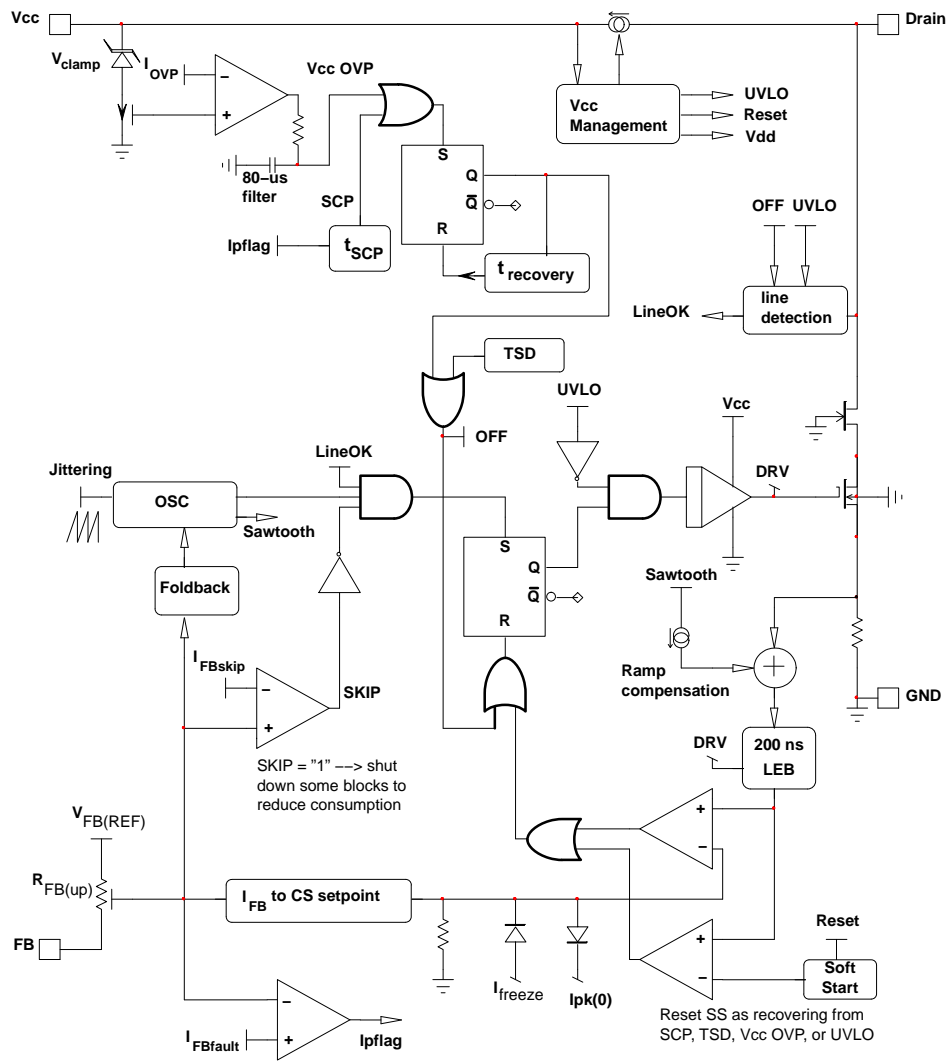


Figure 3. Simplified Internal Circuit Architecture

# NCP1070, NCP1071, NCP1072, NCP1075, NCP1076, NCP1077

## MAXIMUM RATINGS TABLE

Symbol	Rating	Value	Unit	
V <sub>CC</sub>	Power Supply Voltage on all pins, except Pin 5(Drain)	-0.3 to 10	V	
BV <sub>dss</sub>	Drain voltage	-0.3 to 700	V	
I <sub>DS(PK)</sub>	Drain current peak during transformer saturation (T <sub>J</sub> = 150°C, Note 3): NCP1070/71: NCP1072/75: NCP1076/77:	480 870 2200	mA mA mA	
	Drain current peak during transformer saturation (T <sub>J</sub> = 25°C, Note 3): NCP1070/71: NCP1072/75: NCP1076/77:	850 1500 3900	mA mA mA	
I <sub>VCC</sub>	Maximum Current into Pin 1 when Activating the 8.2 V Active Clamp	15	mA	
R <sub>θJ-A</sub>	P Suffix, Case 626A	0.36 Sq. Inch	77	°C/W
	Junction-to-Air, 2.0 oz Printed Circuit Copper Clad	1.0 Sq. Inch		
R <sub>θJ-A</sub>	ST Suffix, Plastic Package Case 318E	0.36 Sq. Inch	74	°C/W
	Junction-to-Air, 2.0 oz Printed Circuit Copper Clad	1.0 Sq. Inch		
T <sub>JMAX</sub>	Maximum Junction Temperature	150	°C	
	Storage Temperature Range	-60 to +150	°C	
	ESD Capability, Human Body Model (All pins except HV)	2	kV	
	ESD Capability, Machine Model	200	V	
	ESD Capability, Charged Device Model	1	kV	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- This device series contains ESD protection and exceeds the following tests:  
Human Body Model 2000 V per JEDEC JESD22-A114-F  
Machine Model Method 200 V per JEDEC JESD22-A115-A  
Charged Device Model 1000 V per JEDEC JESD22-C101E
- This device contains latch-up protection and exceeds 100 mA per JEDEC Standard JESD78
- Maximum drain current I<sub>DS(PK)</sub> is obtained when the transformer saturates. It should not be mixed with short pulses that can be seen at turn on. Figure 4 below provides spike limits the device can tolerate.

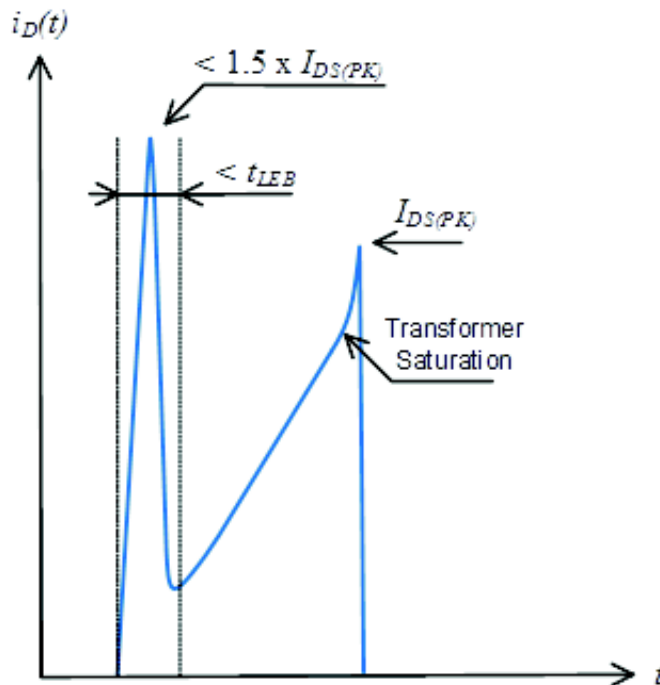


Figure 4. Spike Limits

# NCP1070, NCP1071, NCP1072, NCP1075, NCP1076, NCP1077

## ELECTRICAL CHARACTERISTICS

(For all NCP107X products except NCP1072P100BG: For typical values  $T_J = 25^\circ\text{C}$ , for min/max values  $T_J = -40^\circ\text{C}$  to  $+125^\circ\text{C}$ ,  $V_{CC} = 8\text{ V}$  unless otherwise noted)

(For NCP1072P100BG: For typical values  $T_J = 25^\circ\text{C}$ , for min/max values  $T_J = -55^\circ\text{C}$  (Note 7) to  $+125^\circ\text{C}$ ,  $V_{CC} = 8\text{ V}$  unless otherwise noted)

Symbol	Rating	Pin	Min	Typ	Max	Unit
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### SUPPLY SECTION AND $V_{CC}$ MANAGEMENT

$V_{CC(on)}$	$V_{CC}$ increasing level at which the switcher starts operation NCP1070/71/72/75 NCP1076/77	1 1	7.8 7.7	8.2 8.1	8.6 8.5	V
$V_{CC(min)}$	$V_{CC}$ decreasing level at which the HV current source restarts	1	6.5	6.8	7.2	V
$V_{CC(off)}$	$V_{CC}$ decreasing level at which the switcher stops operation (UVLO)	1	6.1	6.3	6.6	V
$V_{CC(reset)}$	$V_{CC}$ voltage at which the internal latch is reset (guaranteed by design)	1		4		V
$V_{CC(clamp)}$	Offset voltage above $V_{CC(on)}$ at which the internal clamp activates NCP1070/71 NCP1072/75 NCP1076/77	1 1 1	110 130 130	170 190 190	300 300 300	mV
$I_{CC1}$	Internal IC consumption, Mosfet switching NCP1070/71/72/75 NCP1076/77	1 1	– –	0.7 1.0	1.0 1.3	mA
$I_{CCskip}$	Internal IC consumption, FB is 0 V (No switching on MOSFET)	1		360		$\mu\text{A}$

### POWER SWITCH CIRCUIT

$R_{DS(on)}$	Power Switch Circuit on–state resistance ( $I_d = 50\text{ mA}$ ) NCP1070/71 $T_J = 25^\circ\text{C}$ $T_J = 125^\circ\text{C}$ NCP1072/75 $T_J = 25^\circ\text{C}$ $T_J = 125^\circ\text{C}$ NCP1076/77 $T_J = 25^\circ\text{C}$ $T_J = 125^\circ\text{C}$	5	– – – – –	22 38 11 19 4.7 8.7	32 55 16 24 6.9 10.75	$\Omega$
$BV_{DSS}$	Power Switch Circuit & Startup breakdown voltage ( $I_{D(off)} = 120\ \mu\text{A}$ , $T_J = 25^\circ\text{C}$ )	5	700			V
$I_{DSS(off)}$	Power Switch & Startup breakdown voltage off–state leakage current $T_J = 125^\circ\text{C}$ ( $V_{ds} = 700\text{ V}$ )	5		85		$\mu\text{A}$
$t_{on}$ $t_{off}$	Switching characteristics ( $R_L = 50\ \Omega$ , $V_{DS}$ set for $I_{drain} = 0.7 \times I_{lim}$ ) Turn–on time (90% – 10%) Turn–off time (10% – 90%)	5 5		20 10		ns

### INTERNAL START–UP CURRENT SOURCE

$I_{start1}$	High–voltage current source, $V = V_{CC(on)} - 200\text{ mV}$ NCP1070/71/76/77 NCP1072/75	5 5	5.2 5	9.2 9	12.2 12	mA
$I_{start2}$	High–voltage current source, $V_{CC} = 0\text{ V}$	5		0.5		mA
$V_{CCTH}$	$V_{CC}$ Transient level for $I_{start1}$ to $I_{start2}$ toggling point	1	–	2.2	–	V

### CURRENT COMPARATOR

$I_{PK}$	Maximum internal current setpoint at 50% duty cycle FB pin open, $T_J = 25^\circ\text{C}$ NCP1070 NCP1071 NCP1072 NCP1075 NCP1076 NCP1077		– – – – – –	250 350 250 450 650 800	– – – – – –	mA
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Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. The final switch current is:  $I_{PK(0)} / (V_{in}/L_P + S_a) \times V_{in}/L_P + V_{in}/L_P \times t_{prop}$ , with  $S_a$  the built–in slope compensation,  $V_{in}$  the input voltage,  $L_P$  the primary inductor in a flyback, and  $t_{prop}$  the propagation delay.

5. NCP1072 130 kHz on demand only.

6. Oscillator frequency is measured with disabled jittering.

7. For coldest temperature, QA sampling at  $-40^\circ\text{C}$  in production and  $-55^\circ\text{C}$  specification is Guaranteed by Characterization.

# NCP1070, NCP1071, NCP1072, NCP1075, NCP1076, NCP1077

## ELECTRICAL CHARACTERISTICS

(For all NCP107X products except NCP1072P100BG: For typical values  $T_J = 25^\circ\text{C}$ , for min/max values  $T_J = -40^\circ\text{C}$  to  $+125^\circ\text{C}$ ,  $V_{CC} = 8\text{ V}$  unless otherwise noted)

(For NCP1072P100BG: For typical values  $T_J = 25^\circ\text{C}$ , for min/max values  $T_J = -55^\circ\text{C}$  (Note 7) to  $+125^\circ\text{C}$ ,  $V_{CC} = 8\text{ V}$  unless otherwise noted)

Symbol	Rating	Pin	Min	Typ	Max	Unit
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### CURRENT COMPARATOR

$I_{PK(0)}$	Maximum internal current setpoint at beginning of switching cycle FB pin open, $T_J = 25^\circ\text{C}$ NCP1070 NCP1071 NCP1072 NCP1075 NCP1076 NCP1077		273 382 254 467 689 846	304 425 282 508 765 940	334 467 310 549 841 1034	mA
$I_{PKSW}$	Final switch current with a primary slope of 200 mA/ $\mu\text{s}$ , $F_{SW} = 65\text{ kHz}$ (Note 4) NCP1070 NCP1071 NCP1072 NCP1075 NCP1076 NCP1077		– – – – – –	314 427 296 510 732 881	– – – – – –	mA
$I_{PKSW}$	Final switch current with a primary slope of 200 mA/ $\mu\text{s}$ , $F_{SW} = 100\text{ kHz}$ (Note 4) NCP1070 NCP1071 NCP1072 NCP1075 NCP1076 NCP1077		– – – – – –	309 415 293 500 706 845	– – – – – –	mA
$I_{PKSW}$	Final switch current with a primary slope of 200 mA/ $\mu\text{s}$ , $F_{SW} = 130\text{ kHz}$ NCP1070 NCP1071 NCP1072 (Note 5) NCP1075 NCP1076 NCP1077		– – – – – –	303 407 291 493 684 814	– – – – – –	mA
$T_{SS}$	Soft-start duration (guaranteed by design)	–	–	1	–	ms
$T_{LEB}$	Leading Edge Blanking Duration	–	–	200	–	ns
$T_{prop}$	Propagation delay from current detection to drain OFF state	–	–	100	–	ns

### INTERNAL OSCILLATOR

$f_{OSC}$	Oscillation frequency, 65 kHz version, $T_J = 25^\circ\text{C}$ (Note 6)	–	59	65	71	kHz
$f_{OSC}$	Oscillation frequency, 100 kHz version, $T_J = 25^\circ\text{C}$ (Note 6)	–	90	100	110	kHz
$f_{OSC}$	Oscillation frequency, 130 kHz version, $T_J = 25^\circ\text{C}$ (Note 5 et 6)	–	117	130	143	kHz
$f_{jitter}$	Frequency jittering in percentage of $f_{OSC}$	–	–	$\pm 6$	–	%
$f_{swing}$	Jittering swing frequency	–	–	300	–	Hz
$D_{max}$	Maximum duty-cycle NCP1070/71/72/75 except NCP1072P100BG NCP1076/77/72B & NCP1072P100BG	– –	62 65	68 69	72 73	%

### FEEDBACK SECTION

$I_{FBfault}$	FB current for which Fault is detected	4		–35		$\mu\text{A}$
$I_{FB100\%}$	FB current for which internal current set-point is 100% ( $I_{PK(0)}$ )	4		–44		$\mu\text{A}$
$I_{FBfreeze}$	FB current for which internal current set-point is $I_{Freeze}$	4	–	–90	–	$\mu\text{A}$

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

- The final switch current is:  $I_{PK(0)} / (V_{in}/L_P + S_a) \times V_{in}/L_P + V_{in}/L_P \times t_{prop}$ , with  $S_a$  the built-in slope compensation,  $V_{in}$  the input voltage,  $L_P$  the primary inductor in a flyback, and  $t_{prop}$  the propagation delay.
- NCP1072 130 kHz on demand only.
- Oscillator frequency is measured with disabled jittering.
- For coldest temperature, QA sampling at  $-40^\circ\text{C}$  in production and  $-55^\circ\text{C}$  specification is Guaranteed by Characterization.

# NCP1070, NCP1071, NCP1072, NCP1075, NCP1076, NCP1077

## ELECTRICAL CHARACTERISTICS

(For all NCP107X products except NCP1072P100BG: For typical values  $T_J = 25^\circ\text{C}$ , for min/max values  $T_J = -40^\circ\text{C}$  to  $+125^\circ\text{C}$ ,  $V_{CC} = 8\text{ V}$  unless otherwise noted)

(For NCP1072P100BG: For typical values  $T_J = 25^\circ\text{C}$ , for min/max values  $T_J = -55^\circ\text{C}$  (Note 7) to  $+125^\circ\text{C}$ ,  $V_{CC} = 8\text{ V}$  unless otherwise noted)

Symbol	Rating	Pin	Min	Typ	Max	Unit
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### FEEDBACK SECTION

$V_{FB(REF)}$	Equivalent pull-up voltage in linear regulation range (Guaranteed by design)	4		3.3		V
$R_{FB(up)}$	Equivalent feedback resistor in linear regulation range (Guaranteed by design)	4		19.5		k $\Omega$

### FREQUENCY FOLDBACK & SKIP

$I_{FBfold}$	Start of frequency foldback feedback level	4	-	-68	-	$\mu\text{A}$
$I_{FBfold(end)}$	End of frequency foldback feedback level, $F_{sw} = F_{min}$	4	-	-100	-	$\mu\text{A}$
$F_{min}$	The frequency below which skip-cycle occurs	-	21	25	29	kHz
$I_{FBskip}$	The feedback level to enter skip mode	4	-	-120	-	$\mu\text{A}$
$I_{Freeze}$	Internal minimum current setpoint ( $I_{FB} = I_{FBFreeze}$ ) NCP1070 NCP1071 NCP1072 NCP1075 NCP1076 NCP1077	-	-	88 123 88 168 228 280	-	mA

### RAMP COMPENSATION

$S_a(65)$	The internal ramp compensation @ 65 kHz NCP1070 NCP1071 NCP1072 NCP1075 NCP1076 NCP1077	-	-	7 10 4.2 7.5 15 18	-	mA/ $\mu\text{s}$
$S_a(100)$	The internal ramp compensation @ 100 kHz NCP1070 NCP1071 NCP1072 NCP1075 NCP1076 NCP1077	-	-	11 15 6.5 11.5 23 28	-	mA/ $\mu\text{s}$
$S_a(130)$	The internal ramp compensation @ 130 kHz NCP1070 NCP1071 NCP1072 (Note 5) NCP1075 NCP1076 NCP1077	-	-	14 20 8.4 15 30 36	-	

### PROTECTIONS

$t_{SCP}$	Fault validation further to error flag assertion	-	40	53	-	ms
$t_{recovery}$	OFF phase in fault mode NCP1070/1/2/5/6/7 NCP1072P100BG	-	-	420 210	-	ms
$I_{OVP}$	$V_{CC}$ clamp current at which the switcher stops pulsing NCP1070/71 NCP1072/75/76/77	1	6.2 6	8.7 8.5	11.2 11	mA
$t_{OVP}$	The filter of $V_{CC}$ OVP comparator	-	-	80	-	$\mu\text{s}$

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

- The final switch current is:  $I_{PK(0)} / (V_{in}/L_P + S_a) \times V_{in}/L_P + V_{in}/L_P \times t_{prop}$ , with  $S_a$  the built-in slope compensation,  $V_{in}$  the input voltage,  $L_P$  the primary inductor in a flyback, and  $t_{prop}$  the propagation delay.
- NCP1072 130 kHz on demand only.
- Oscillator frequency is measured with disabled jittering.
- For coldest temperature, QA sampling at  $-40^\circ\text{C}$  in production and  $-55^\circ\text{C}$  specification is Guaranteed by Characterization.



# NCP1070, NCP1071, NCP1072, NCP1075, NCP1076, NCP1077

## ELECTRICAL CHARACTERISTICS

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(For NCP1072P100BG: For typical values  $T_J = 25^\circ\text{C}$ , for min/max values  $T_J = -55^\circ\text{C}$  (Note 7) to  $+125^\circ\text{C}$ ,  $V_{CC} = 8\text{ V}$  unless otherwise noted)

Symbol	Rating	Pin	Min	Typ	Max	Unit
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### PROTECTIONS

$V_{HV(EN)}$	The drain pin voltage above which allows MOSFET operate, which is detected after TSD, UVLO, SCP, or $V_{CC}$ OVP mode.	5	72	91	110	V
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### TEMPERATURE MANAGEMENT

TSD	Temperature shutdown (Guaranteed by design)	–	150			$^\circ\text{C}$
	Hysteresis in shutdown (Guaranteed by design)	–		50		$^\circ\text{C}$

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. The final switch current is:  $I_{PK(0)} / (V_{in}/L_P + S_a) \times V_{in}/L_P + V_{in}/L_P \times t_{prop}$ , with  $S_a$  the built-in slope compensation,  $V_{in}$  the input voltage,  $L_P$  the primary inductor in a flyback, and  $t_{prop}$  the propagation delay.
5. NCP1072 130 kHz on demand only.
6. Oscillator frequency is measured with disabled jittering.
7. For coldest temperature, QA sampling at  $-40^\circ\text{C}$  in production and  $-55^\circ\text{C}$  specification is Guaranteed by Characterization.

TYPICAL CHARACTERISTICS

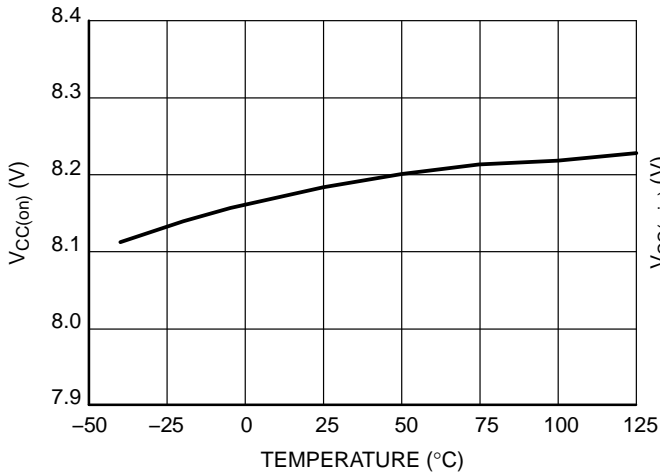


Figure 5. V<sub>CC(on)</sub> vs. Temperature

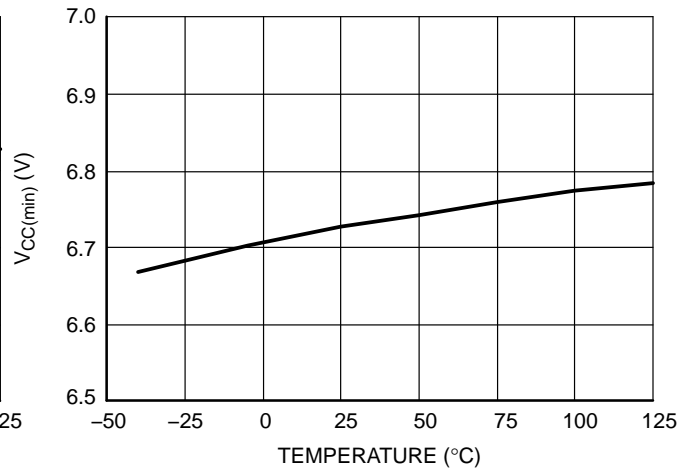


Figure 6. V<sub>CC(min)</sub> vs. Temperature

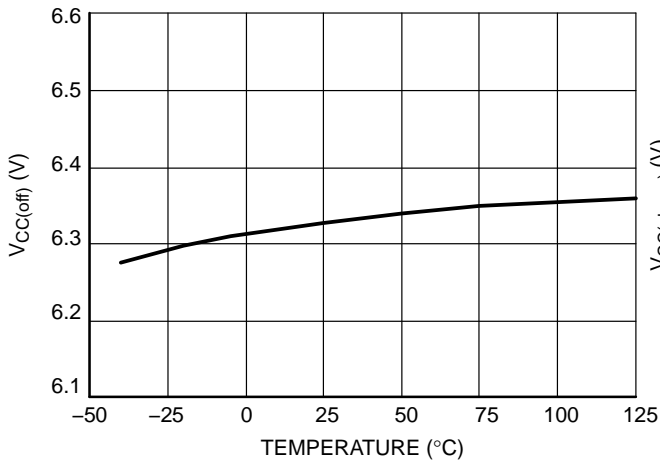


Figure 7. V<sub>CC(off)</sub> vs. Temperature

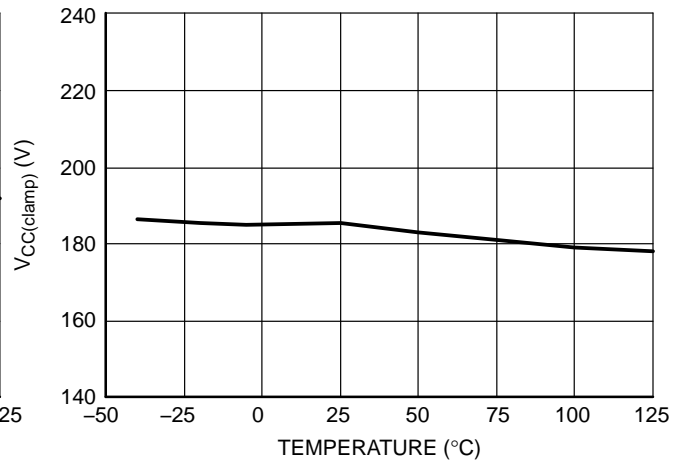


Figure 8. V<sub>CC(clamp)</sub> vs. Temperature

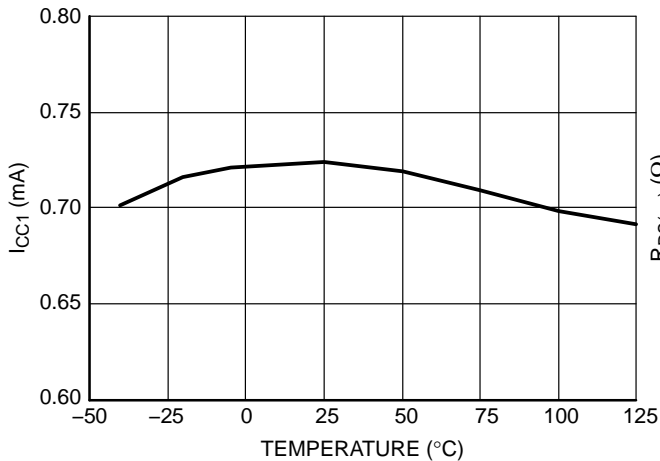


Figure 9. I<sub>CC1</sub> vs. Temperature

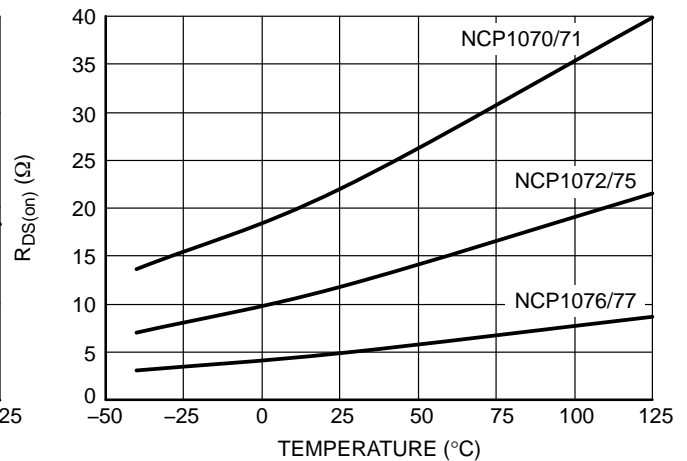


Figure 10. R<sub>DS(on)</sub> vs. Temperature

TYPICAL CHARACTERISTICS

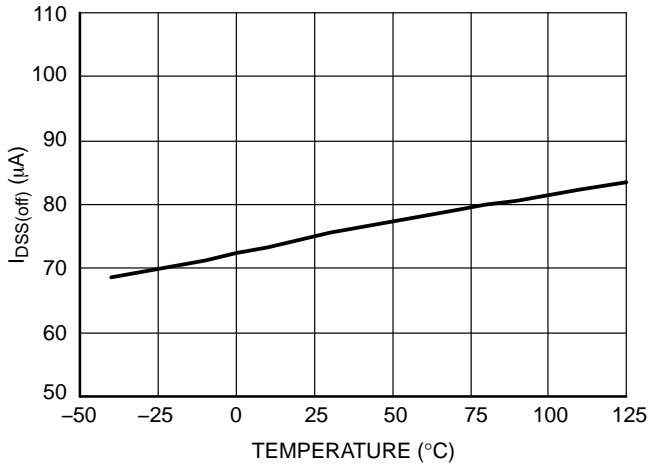


Figure 11.  $I_{DSS(off)}$  vs. Temperature

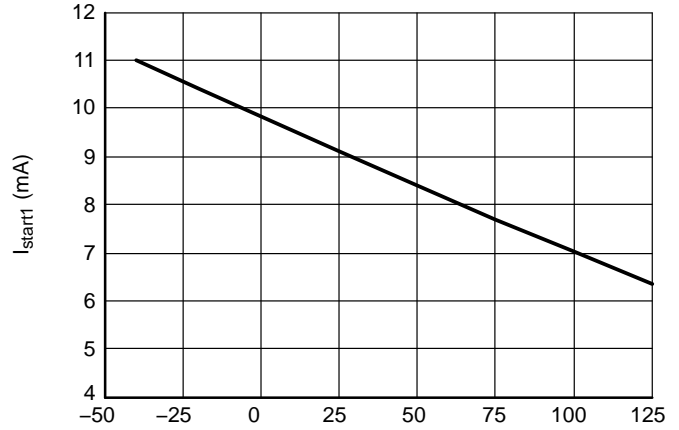


Figure 12.  $I_{start1}$  vs. Temperature

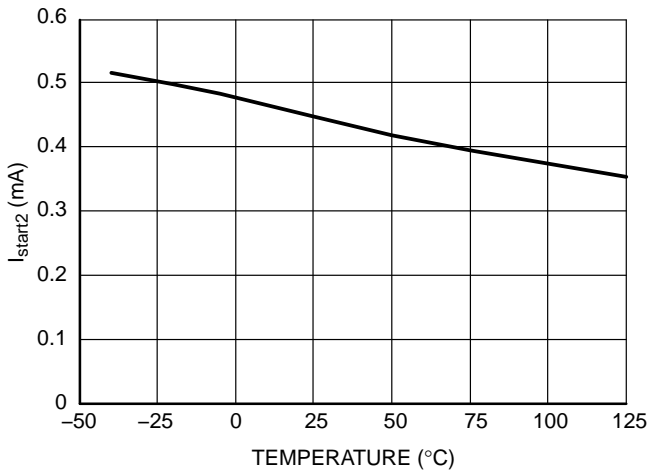


Figure 13.  $I_{start2}$  vs. Temperature

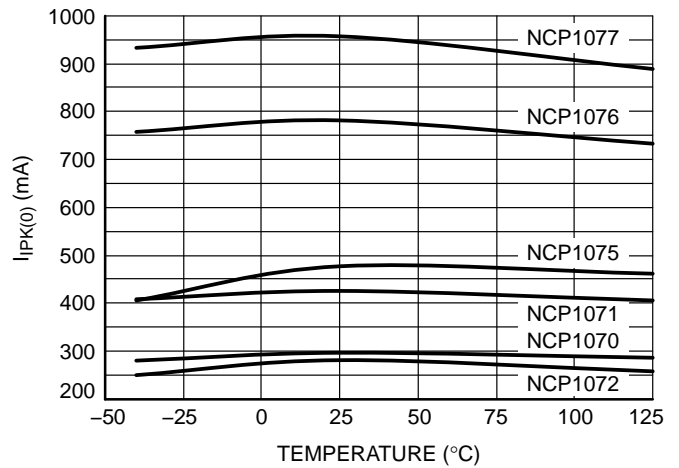


Figure 14.  $I_{IPK(0)}$  vs. Temperature

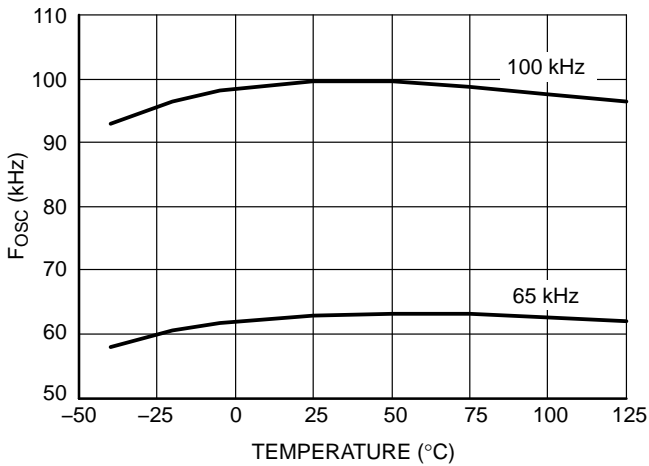


Figure 15.  $F_{osc}$  vs. Temperature

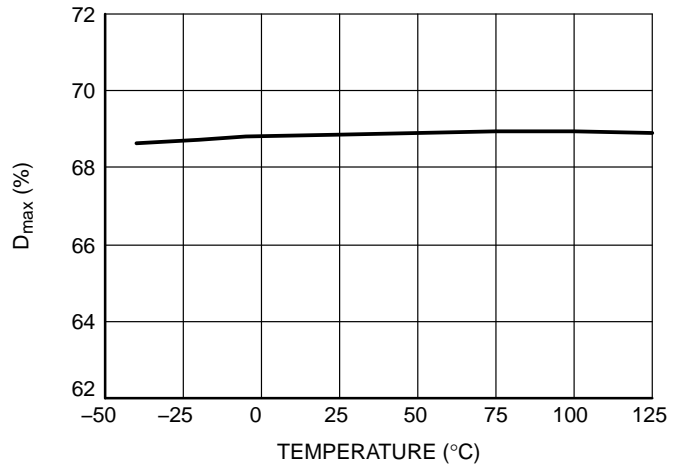


Figure 16.  $D_{(max)}$  vs. Temperature

TYPICAL CHARACTERISTICS

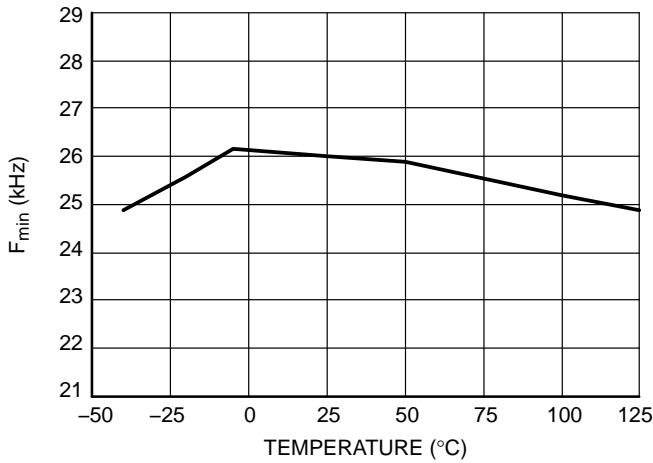


Figure 17. F<sub>min</sub> vs. Temperature

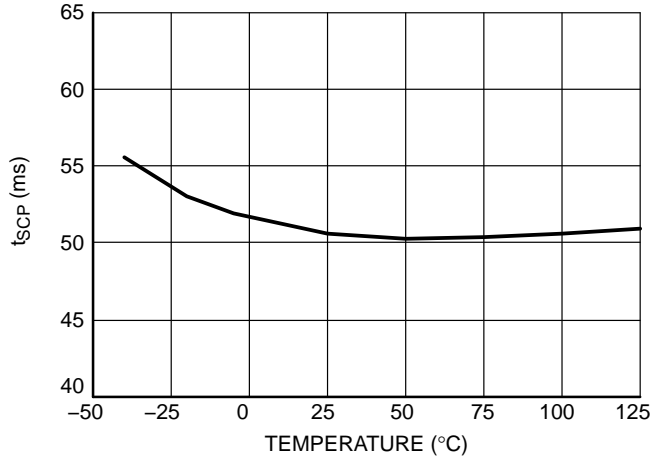


Figure 18. t<sub>SCP</sub> vs. Temperature

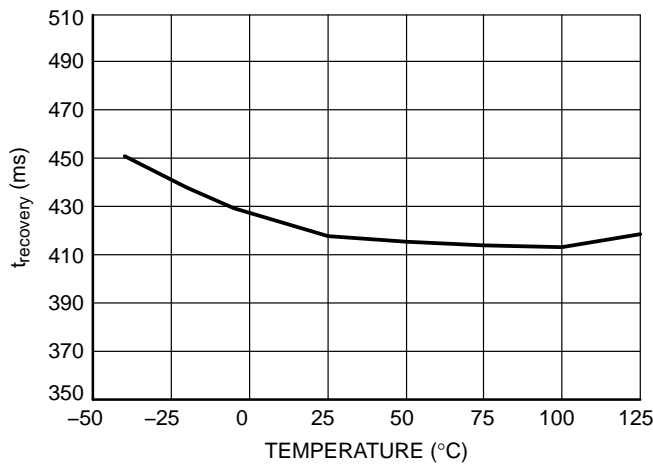


Figure 19. t<sub>recovery</sub> vs. Temperature

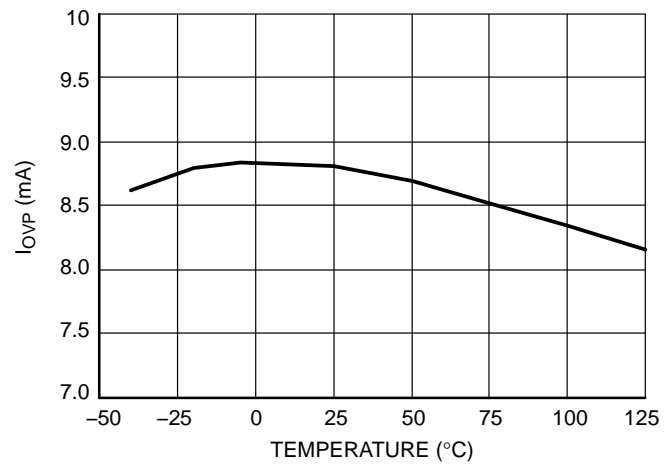


Figure 20. I<sub>OVP</sub> vs. Temperature

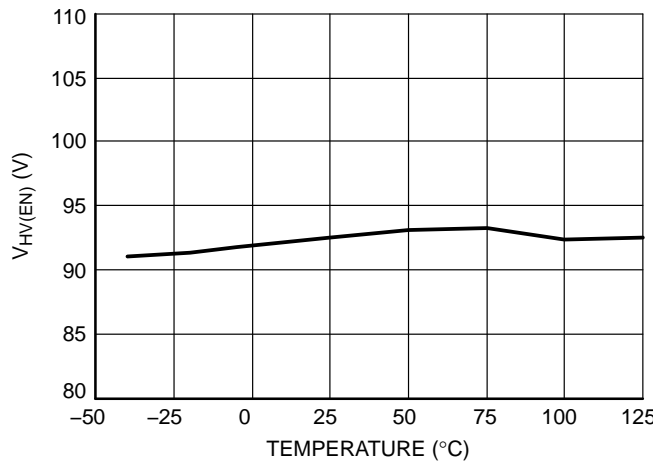


Figure 21. V<sub>HV(EN)</sub> vs. Temperature

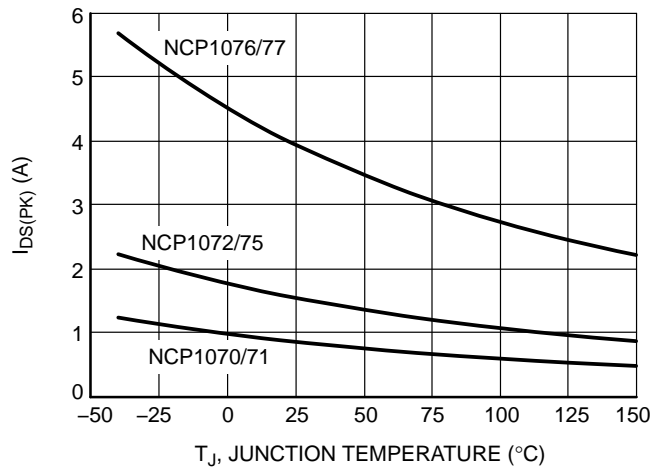


Figure 22. Drain Current Peak during Transformer Saturation vs. Junction Temperature

TYPICAL CHARACTERISTICS

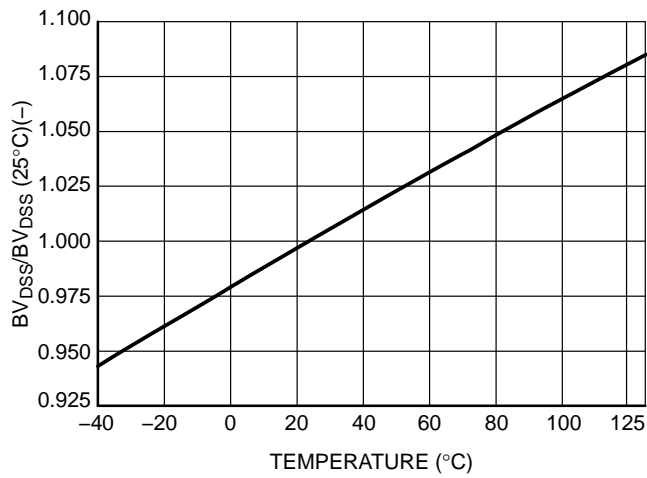


Figure 23. Breakdown Voltage vs. Temperature

## APPLICATION INFORMATION

### Introduction

The NCP107x offers a complete current-mode control solution. The component integrates everything needed to build a rugged and low-cost Switch-Mode Power Supply (SMPS) featuring low standby power. The Quick Selection Table on page 2 details the differences between references, mainly peak current setpoints and operating frequency.

- Current-mode operation: the controller uses current-mode control architecture.
- 700 V Power MOSFET: Due to ON Semiconductor Very High Voltage Integrated Circuit technology, the circuit hosts a high-voltage power MOSFET featuring a  $22/11/4.7 \Omega R_{DS(on)} - T_J = 25^\circ\text{C}$ . This value lets the designer build a power supply up to respectively 7.75 W, 10 W and 15 W operated on universal mains. An internal current source delivers the startup current, necessary to crank the power supply.
- Dynamic Self-Supply: Due to the internal high voltage current source, this device could be used in the application without the auxiliary winding to provide supply voltage.
- Short circuit protection: by permanently monitoring the feedback line activity, the IC is able to detect the presence of a short-circuit, immediately reducing the output power for a total system protection. A  $t_{SCP}$  timer is started as soon as the feedback current is below threshold,  $I_{FB(fault)}$ , which indicates the maximum peak current. If at the end of this timer the fault is still present, then the device enters a safe, auto-recovery burst mode, affected by a fixed timer recurrence,  $t_{recovery}$ . Once the short has disappeared, the controller resumes and goes back to normal operation.
- Built-in  $V_{CC}$  Over Voltage Protection: when the auxiliary winding is used to bias the  $V_{CC}$  pin (no DSS), an internal active clamp connected between  $V_{CC}$  and ground limits the supply dynamics to  $V_{CC(clamp)}$ . In case the current injected in this clamp exceeds a level of 6.0 mA (minimum), the controller immediately stops switching and waits a full timer period ( $t_{recovery}$ ) before

attempting to restart. If the fault is gone, the controller resumes operation. If the fault is still there, e.g. a broken opto-coupler, the controller protects the load through a safe burst mode.

- Line detection: An internal comparator monitors the drain voltage as recovering from one of the following situations:
  - ◆ Short Circuit Protection,
  - ◆  $V_{CC}$  OVP is confirmed,
  - ◆ UVLO
  - ◆ TSD

If the drain voltage is lower than the internal threshold ( $V_{HV(EN)}$ ), the internal power switch is inhibited. This avoids operating at too low ac input. This is also called brown-in function in some fields.

- Frequency jittering: an internal low-frequency modulation signal varies the pace at which the oscillator frequency is modulated. This helps spreading out energy in conducted noise analysis. To improve the EMI signature at low power levels, the jittering remains active in frequency foldback mode.
- Soft-Start: a 1 ms soft-start ensures a smooth startup sequence, reducing output overshoots.
- Frequency foldback capability: a continuous flow of pulses is not compatible with no-load/light-load standby power requirements. To excel in this domain, the controller observes the feedback current information and when it reaches a level of  $I_{FBfold}$ , the oscillator then starts to reduce its switching frequency as the feedback current continues to increase (the power demand continues to reduce). It can go down to 25 kHz (typical) reached for a feedback level of  $I_{FBfold(end)}$  (100  $\mu\text{A}$  roughly). At this point, if the power continues to drop, the controller enters classical skip-cycle mode.
- Skip: if SMPS naturally exhibits a good efficiency at nominal load, they begin to be less efficient when the output power demand diminishes. By skipping un-needed switching cycles, the NCP107x drastically reduces the power wasted during light load conditions.



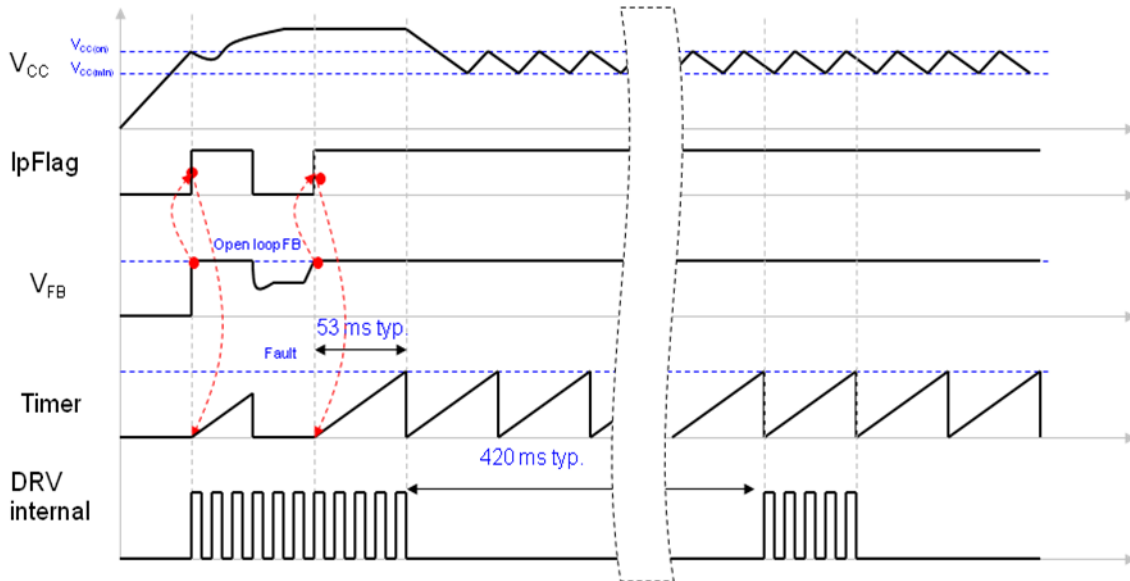




**Fault Condition – Output Short–Circuit**

As soon as  $V_{CC}$  reaches  $V_{CC(on)}$ , drive pulses are internally enabled. If everything is correct, the auxiliary winding increases the voltage on the  $V_{CC}$  pin as the output voltage rises. During the start–sequence, the controller smoothly ramps up the peak drain current to maximum setting, i.e.  $I_{PK}$ , which is reached after a typical period of 1 ms. When the output voltage is not regulated, the current coming through FB pin is below  $I_{FBfault}$  level (35  $\mu$ A typically), which is not only during the startup period but also anytime an overload occurs, an internal error flag is

asserted, Ipflag, indicating that the system has reached its maximum current limit set point. The assertion of this flag triggers a fault counter  $t_{SCP}$  (53 ms typically). If at counter completion, Ipflag remains asserted, all driving pulses are stopped and the part stays off in  $t_{recovery}$  duration (about 420 ms). A new attempt to re–start occurs and will last 53 ms providing the fault is still present. If the fault still affects the output, a safe burst mode is entered, affected by a low duty–cycle operation (11%). When the fault disappears, the power supply quickly resumes operation. Figure 26 depicts this particular mode:



**Figure 26. In Case of Short–Circuit or Overload, the NCP107X Protects Itself and the Power Supply Via a Low Frequency Burst Mode. The  $V_{CC}$  is Maintained by the Current Source and Self–supplies the Controller.**

**Auto–Recovery Over Voltage Protection**

The particular NCP107X arrangement offers a simple way to prevent output voltage runaway when the optocoupler fails. As Figure 27 shows, an active zener diode monitors and protects the  $V_{CC}$  pin. Below its equivalent breakdown voltage, that is to say 8.4 V typical, no current flows in it. If the auxiliary  $V_{CC}$  pushes too much current inside the zener, then the controller considers an OVP situation and stops the internal drivers. When an OVP occurs, all switching pulses are permanently disabled. After  $t_{recovery}$  delay, it resumes the internal drivers. If the failure symptom still exists, e.g. feedback opto–coupler fails, the device keeps the auto–recovery OVP mode.

Figure 27 shows that the insertion of a resistor ( $R_{limit}$ ) between the auxiliary dc level and the  $V_{CC}$  pin is mandatory a) not to damage the internal 8.4 V zener diode during an overshoot for instance (absolute maximum current is 15 mA) b) to implement the fail–safe optocoupler protection (OVP) as offered by the active clamp. Please note that there cannot be bad interaction between the clamping voltage of the internal zener and  $V_{CC(on)}$  since this clamping voltage is actually built on top of  $V_{CC(on)}$  with a fixed amount of offset (200 mV typical).  $R_{limit}$  should be carefully selected to avoid

triggering the OVP as we discussed, but also to avoid disturbing the  $V_{CC}$  in low / light load conditions. The below lines detail how to evaluate the  $R_{limit}$  value...

Self–supplying controllers in extremely low standby applications often puzzles the designer. Actually, if a SMPS operated at nominal load can deliver an auxiliary voltage of an arbitrary 16 V ( $V_{nom}$ ), this voltage can drop below 10 V ( $V_{stby}$ ) when entering standby. This is because the recurrence of the switching pulses expands so much that the low frequency re–fueling rate of the  $V_{CC}$  capacitor is not enough to keep a proper auxiliary voltage. Figure 28 portrays a typical scope shot of a SMPS entering deep standby (output un–loaded). Thus, care must be taken when calculating  $R_{limit}$  1) to not trigger the  $V_{CC}$  over current latch (by injecting 6 mA into the active clamp – always use the minimum value for worse case design) in normal operation but 2) not to drop too much voltage over  $R_{limit}$  when entering standby. Otherwise, the converter will enter dynamic self supply mode (DSS mode), which increases the power dissipation. Based on these recommendations, we are able to bound  $R_{limit}$  between two equations:



## NCP1070, NCP1071, NCP1072, NCP1075, NCP1076, NCP1077

almost impossible exercise since many parameters are involved, including the converter time constants. Fine tuning of  $R_{limit}$  thus requires a few iterations and experiments on a breadboard to check the auxiliary voltage

variations but also the output voltage excursion in fault. Once properly adjusted, the fail-safe protection will preclude any lethal voltage runaways in case a problem would occur in the feedback loop.

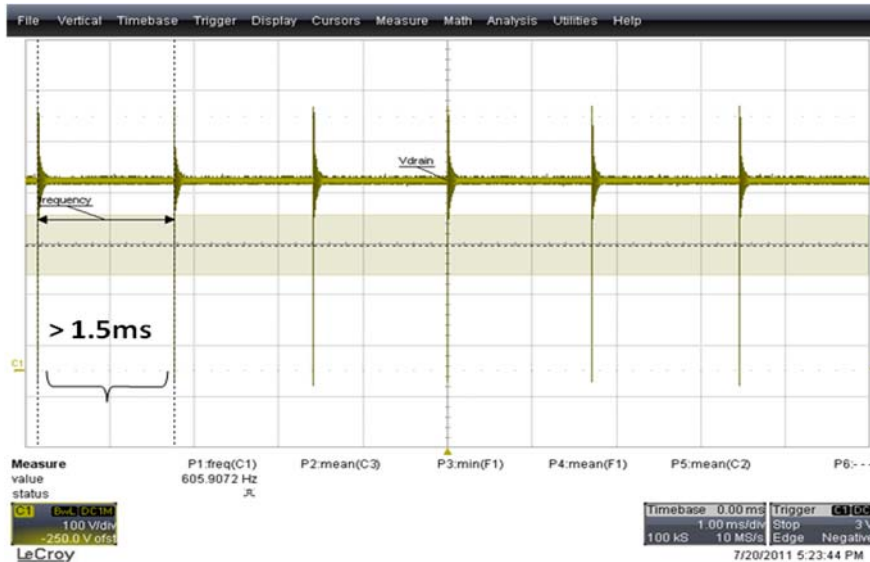


Figure 28. The Burst Frequency Becomes so Low That it is Difficult to Keep an Adequate Level on the Auxiliary  $V_{CC}$ ...

Figure 29 describes the main signal variations when the part operates in auto-recovery OVP:

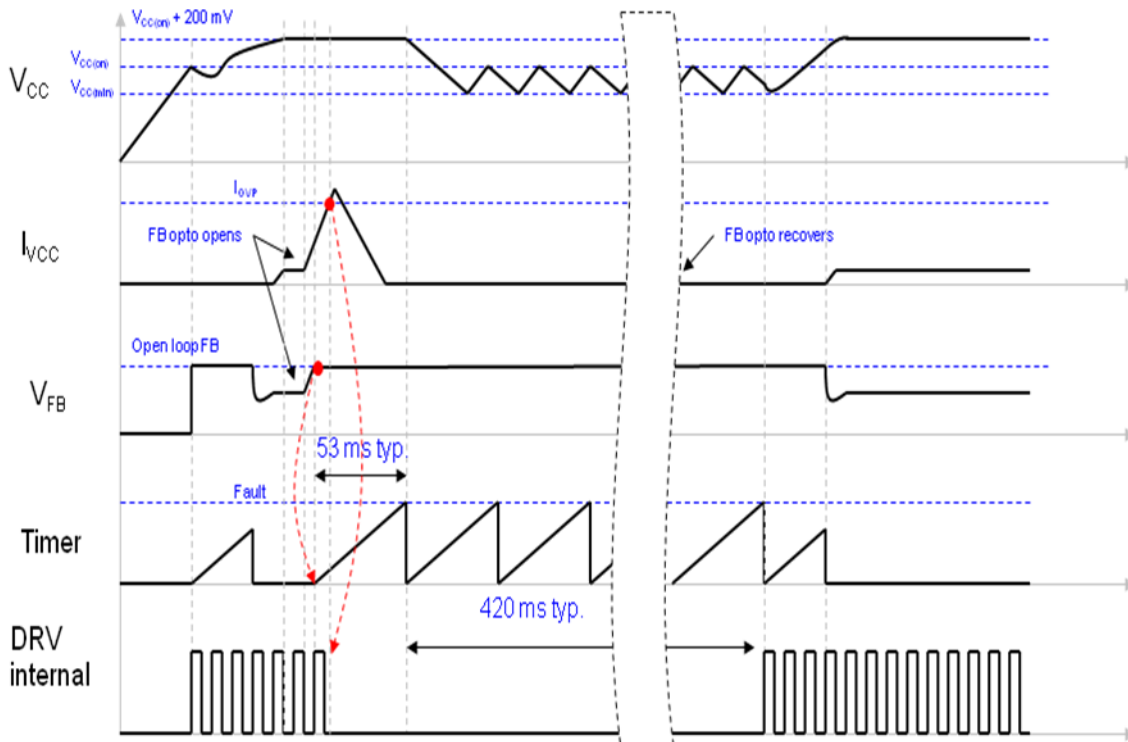


Figure 29. If the  $V_{CC}$  Current Exceeds a Certain Threshold, an Auto-Recovery Protection is Activated

**Improving the precision in auto-recovery OVP**

Given the OVP variations the internal trip current dispersion incur, it is sometimes more interesting to explore a different solution, improving the situation to the cost of a minimal amount of surrounding elements. Figure 30 shows that adding a simple zener diode on top of the limiting resistor, offers a better precision since what matters now is the internal  $V_{CC(on)}$  breakdown plus the zener voltage. A resistor in series with the zener diodes keeps the maximum current in the  $V_{CC}$  pin below the maximum rating of 15 mA just before trip the OVP.

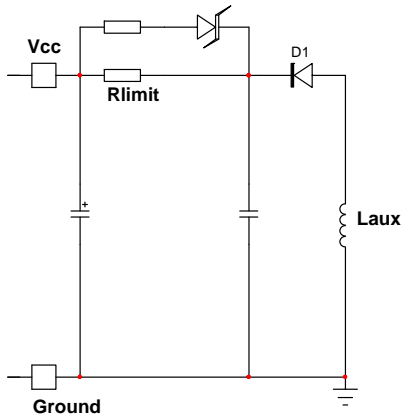


Figure 30. A Simple Zener Diode Added in Parallel

**Soft-Start**

The NCP107X features a 1 ms soft-start which reduces the power-on stress but also contributes to lower the output overshoot. Figure 31 shows a typical operating waveform. The NCP107X features a novel patented structure which offers a better soft-start ramp, almost ignoring the start-up pedestal inherent to traditional current-mode supplies:

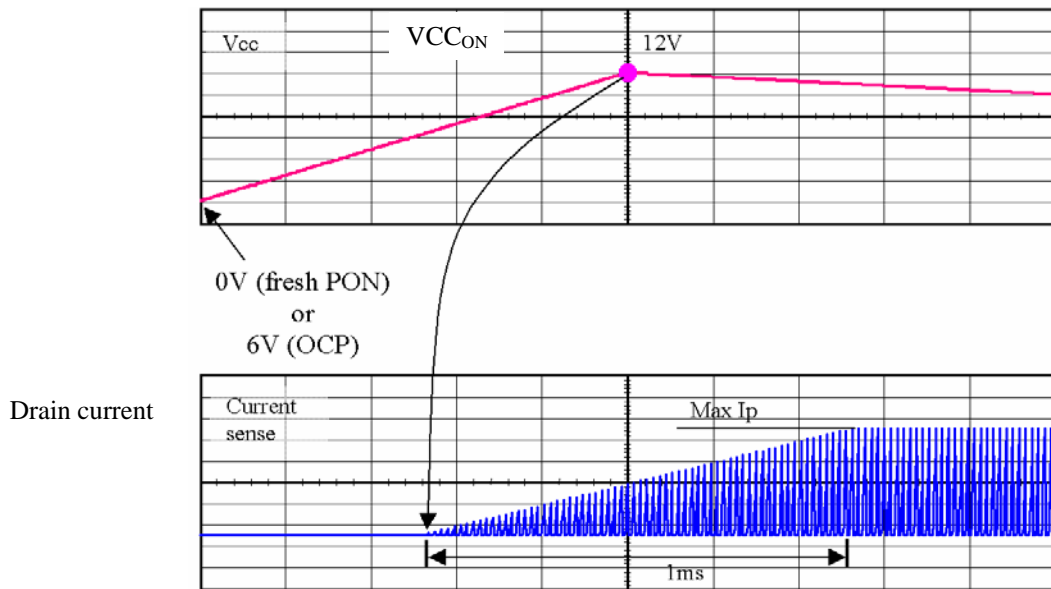


Figure 31. The 1 ms soft-start sequence

**Jittering**

Frequency jittering is a method used to soften the EMI signature by spreading the energy in the vicinity of the main switching component. The NCP107X offers a  $\pm 6\%$  deviation of the nominal switching frequency. The sweep

sawtooth is internally generated and modulates the clock up and down with a fixed frequency of 300 Hz. Figure 32 shows the relationship between the jitter ramp and the frequency deviation. It is not possible to externally disable the jitter.

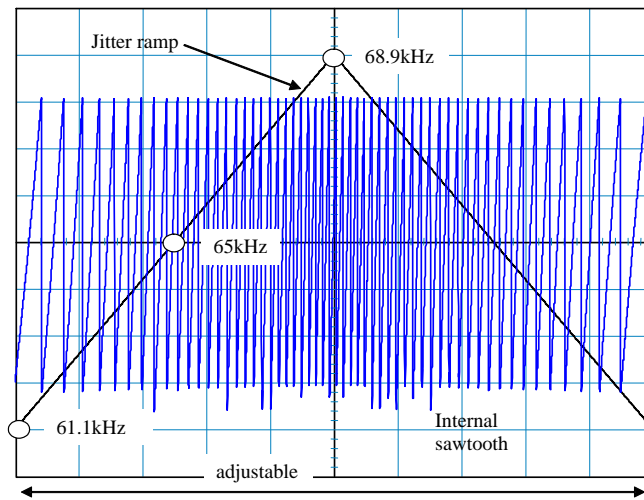


Figure 32. Modulation Effects on the Clock Signal by the Jittering Sawtooth

**Line Detection**

An internal comparator monitors the drain voltage as recovering from one of the following situations:

- Short Circuit Protection,
- $V_{CC}$  OVP is confirmed,
- UVLO
- TSD

If the drain voltage is lower than the internal threshold  $V_{HV(EN)}$  (91 Vdc typically), the internal power switch is inhibited. This avoids operating at too low ac input. This is also called brown-in function in some fields.

**Frequency Foldback**

The reduction of no-load standby power associated with the need for improving the efficiency, requires to change the traditional fixed-frequency type of operation. This device implements a switching frequency foldback when the feedback current passes above a certain level,  $I_{FBfold}$ , set around 68  $\mu A$ . At this point, the oscillator enters frequency foldback and reduces its switching frequency.

The internal peak current set-point is following the feedback current information until its level reaches the minimal freezing level point of  $I_{Freeze}$ . The only way to further reduce the transmitted power is to diminish the operating frequency down to  $F_{min}$  (25 kHz typically). This value is reached at a feedback current level of  $I_{FBfold(end)}$ . Below this point, if the output power continues to decrease, the part enters skip cycle for the best noise-free performance in no-load conditions. Figures 33 and 34 depict the adopted scheme for the part.

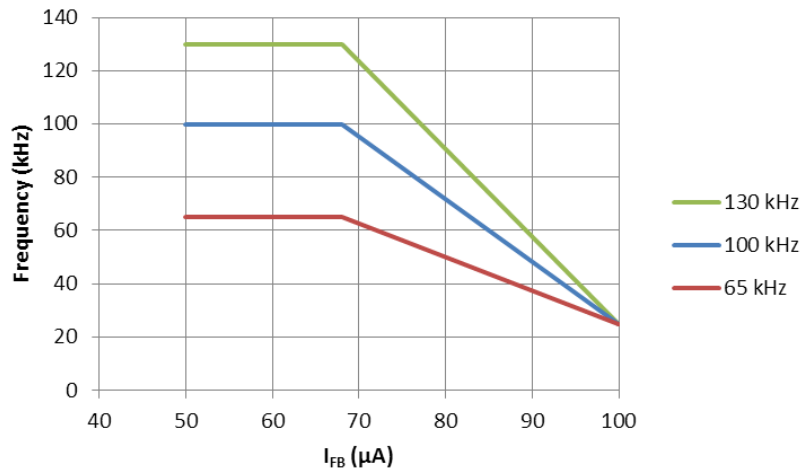


Figure 33. By Observing the Current on the Feedback Pin, the Controller Reduces its Switching Frequency for an Improved Performance at Light Load

## NCP1070, NCP1071, NCP1072, NCP1075, NCP1076, NCP1077

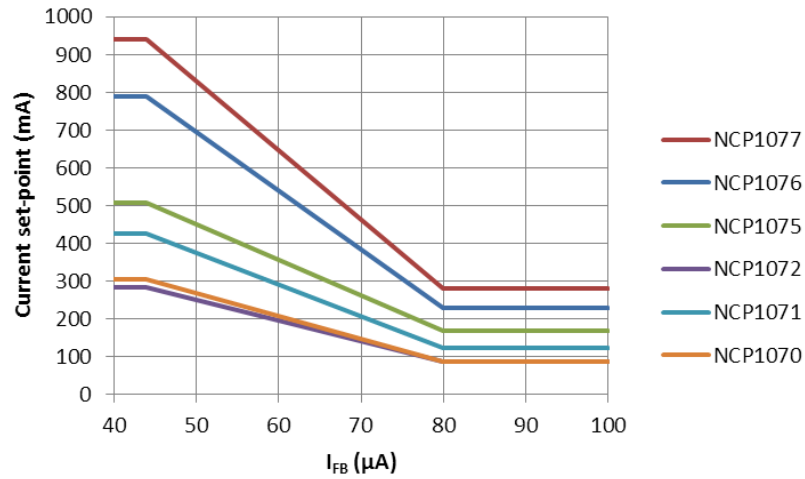


Figure 34. Ipk Set-point is Frozen at Lower Power Demand.

### Feedback and Skip

Figure 35 depicts the relationship between feedback voltage and current. The feedback pin operates linearly as the absolute value of feedback current ( $I_{FB}$ ) is above  $40 \mu A$ .

In this linear operating range, the dynamic resistance is  $19.5 k\Omega$  typically ( $R_{FB(up)}$ ) and the effective pull up voltage is  $3.3 V$  typically ( $V_{FB(REF)}$ ). When  $I_{FB}$  is below  $40 \mu A$ , the FB voltage will jump to close to  $4.5 V$ .

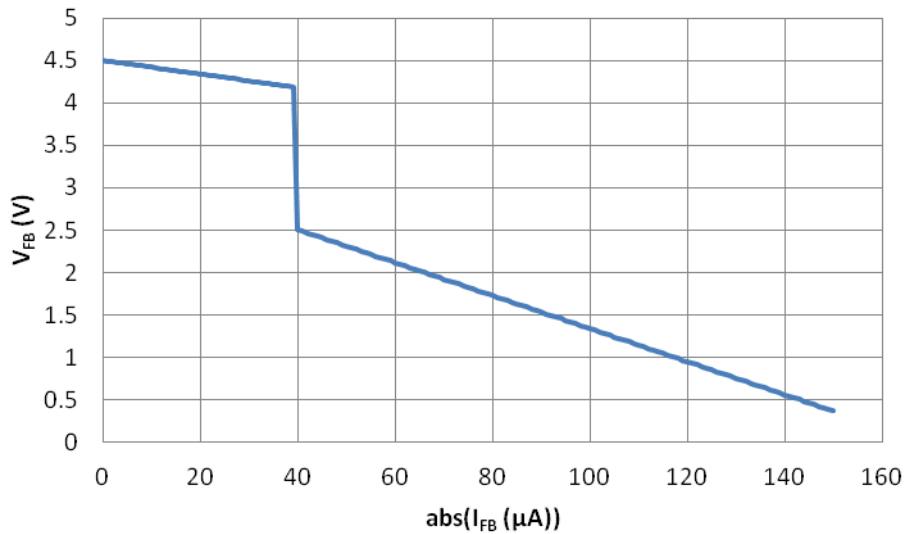


Figure 35. Feedback Voltage vs. Current

Figure 36 depicts the skip mode block diagram. When the FB current information reaches  $I_{FB(skip)}$ , the internal clock to set the flip-flop is blanked and the internal consumption of the controller is decreased. The hysteresis of internal skip

comparator is minimized to lower the ripple of the auxiliary voltage for  $V_{CC}$  pin and  $V_{OUT}$  of power supply during skip mode. It eases the design of  $V_{CC}$  over load range.

# NCP1070, NCP1071, NCP1072, NCP1075, NCP1076, NCP1077

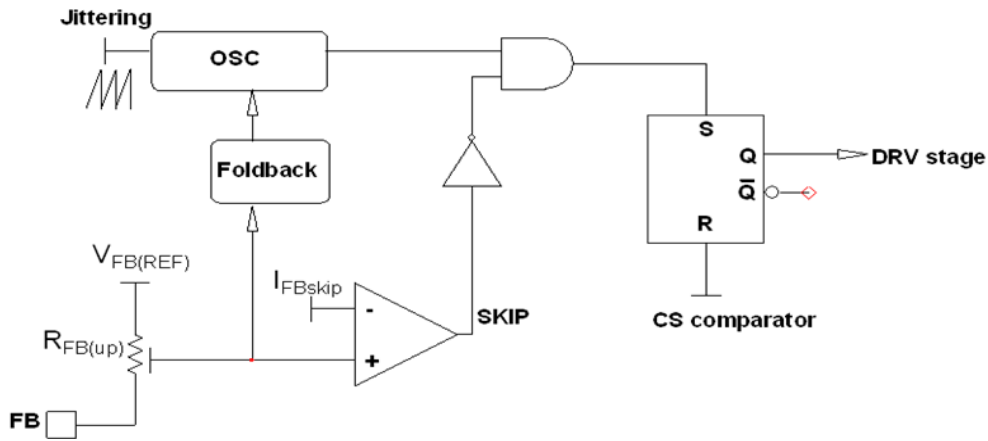


Figure 36. Skip Cycle Schematic

## Ramp Compensation and Ipk Set-point

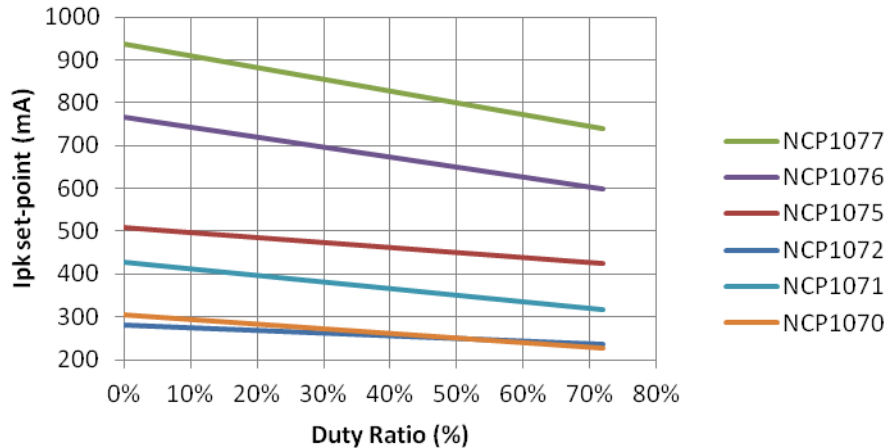
In order to allow the NCP107X to operate in CCM with a duty cycle above 50%, a fixed slope compensation is internally applied to the current-mode control.

Here we got a table of the ramp compensation, the initial current set point, and the final current set-point of different versions of switcher.

	Fsw	Sa	Ipk(Duty = 50%)	Ipk(0)
NCP1070	65 kHz	7 mA/μs	250 mA	304 mA
	100 kHz	11 mA/μs		
	130 kHz	14 mA/μs		
NCP1071	65 kHz	10 mA/μs	350 mA	425 mA
	100 kHz	15 mA/μs		
	130 kHz	20 mA/μs		
NCP1072	65 kHz	4.2 mA/μs	250 mA	282 mA
	100 kHz	6.5 mA/μs		
	130 kHz	8.4 mA/μs		
NCP1075	65 kHz	7.5 mA/μs	450 mA	508 mA
	100 kHz	11.5 mA/μs		
	130 kHz	15 mA/μs		
NCP1076	65 kHz	15 mA/μs	650 mA	765 mA
	100 kHz	23 mA/μs		
	130 kHz	30 mA/μs		
NCP1077	65 kHz	18 mA/μs	800 mA	940 mA
	100 kHz	28 mA/μs		
	130 kHz	36 mA/μs		

## NCP1070, NCP1071, NCP1072, NCP1075, NCP1076, NCP1077

The Figure 37 depicts the variation of  $I_{PK}$  set-point vs. the power switcher duty ratio, which is caused by the internal ramp compensation.



**Figure 37.  $I_{PK}$  Set-point Varies with Power Switch On Time, Which is Caused by the Ramp Compensation**

### Design Procedure

The design of an SMPS around a monolithic device does not differ from that of a standard circuit using a controller and a MOSFET. However, one needs to be aware of certain characteristics specific of monolithic devices. Let us follow the steps:

$V_{in\ min} = 90\ V_{ac}$  or  $127\ V_{dc}$  once rectified, assuming a low bulk ripple

$V_{in\ max} = 265\ V_{ac}$  or  $375\ V_{dc}$

$V_{out} = 12\ V$

$P_{out} = 10\ W$

Operating mode is CCM

$\eta = 0.8$

1. The lateral MOSFET body-diode shall never be forward biased, either during start-up (because of a large leakage inductance) or in normal operation as shown by Figure 38. This condition sets the

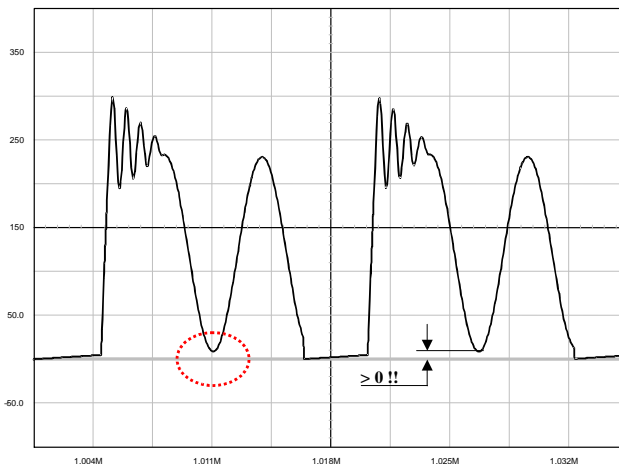
maximum voltage that can be reflected during  $t_{off}$ . As a result, the Flyback voltage which is reflected on the drain at the switch opening cannot be larger than the input voltage. When selecting components, you thus must adopt a turn ratio which adheres to the following equation:

$$N(V_{out} + V_f) < V_{in,min} \quad (\text{eq. 3})$$

2. In our case, since we operate from a  $127\ V$  DC rail while delivering  $12\ V$ , we can select a reflected voltage of  $120\ V_{dc}$  maximum. Therefore, the turn ratio  $N_p:N_s$  must be smaller than

$$\frac{V_{reflect}}{V_{out} + V_f} = \frac{120}{12 + 0.5} = 9.6$$

or  $N_p:N_s < 9.6$ . Here we choose  $N = 8$  in this case. We will see later on how it affects the calculation.



**Figure 38. The Drain-Source Wave Shall Always be Positive**



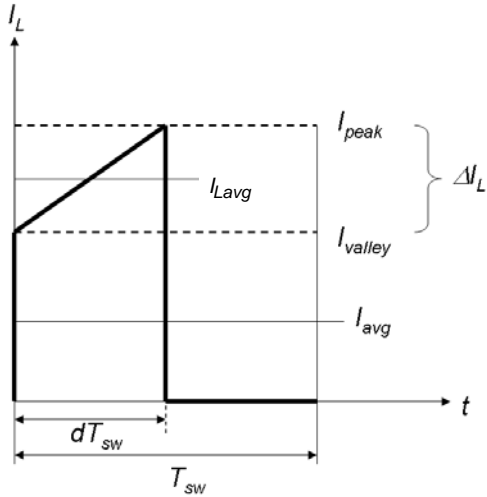


Figure 39. Primary Inductance Current Evolution in CCM

3. Lateral MOSFETs have a poorly doped body–diode which naturally limits their ability to sustain the avalanche. A traditional RCD clamping network shall thus be installed to protect the MOSFET. In some low power applications, a simple capacitor can also be used since

$$V_{\text{drain,max}} = V_{\text{in}} + N(V_{\text{out}} + V_f) + I_{\text{peak}} \sqrt{\frac{L_f}{C_{\text{tot}}}} \quad (\text{eq. 4})$$

where  $L_f$  is the leakage inductance,  $C_{\text{tot}}$  the total capacitance at the drain node (which is increased by the capacitor you will wire between drain and source),  $N$  the  $N_p:N_s$  turn ratio,  $V_{\text{out}}$  the output voltage,  $V_f$  the secondary diode forward drop and finally,  $I_{\text{peak}}$  the maximum peak current. Worst case occurs when the SMPS is very close to regulation, e.g. the  $V_{\text{out}}$  target is almost reached and  $I_{\text{peak}}$  is still pushed to the maximum. For this design, we have selected our maximum voltage around 650 V (at  $V_{\text{in}} = 375$  Vdc). This voltage is given by the RCD clamp installed from the drain to the bulk voltage. We will see how to calculate it later on.

4. Calculate the maximum operating duty–cycle for this flyback converter operated in CCM:

$$d_{\text{max}} = \frac{N(V_{\text{out}} + V_f)}{N(V_{\text{out}} + V_f) + V_{\text{in,min}}} = \frac{1}{1 + \frac{V_{\text{in,min}}}{N(V_{\text{out}} + V_f)}} = 0.44 \quad (\text{eq. 5})$$

5. To obtain the primary inductance, we have the choice between two equations:

$$L = \frac{(V_{\text{in}}d)^2}{f_{\text{sw}}K P_{\text{in}}} \quad (\text{eq. 6})$$

where

$$K = \frac{\Delta I_L}{I_{\text{Lavg}}}$$

and defines the amount of ripple we want in CCM (see Figure 39).

- Small  $K$ : deep CCM, implying a large primary inductance, a low bandwidth and a large leakage inductance.
- Large  $K$ : approaching BCM where the rms losses are worse, but smaller inductance, leading to a better leakage inductance.

From Equation 6, a  $K$  factor of 1 (50% ripple), gives an inductance of:

$$L = \frac{(127 \times 0.44)^2}{65k \times 1 \times 12.75} = 3.8 \text{ mH}$$

$$\Delta I_L = \frac{V_{\text{in,min}} \cdot d_{\text{max}}}{L F_{\text{SW}}} = \frac{127 \times 0.44}{3.8 \times 65k}$$

$$= 223 \text{ mA peak-to-peak}$$

The peak current can be evaluated to be:

$$I_{\text{peak}} = \frac{I_{\text{avg}}}{d} + \frac{\Delta I_L}{2} = I_{\text{peak}} = \frac{98\text{m}}{0.44} + \frac{\Delta I_L}{2} = 335 \text{ mA}$$

On  $I_L$ ,  $I_{\text{Lavg}}$  can also be calculated:

$$I_{\text{Lavg}} = I_{\text{peak}} - \frac{\Delta I_L}{2} = 0.34 - 0.112 = 223 \text{ mA}$$

6. Based on the above numbers, we can now evaluate the conduction losses:

$$I_{\text{d,rms}} = \sqrt{d \left( I_{\text{peak}}^2 - I_{\text{peak}} \Delta I_L + \frac{\Delta I_L^2}{3} \right)} = \sqrt{0.44 \left( 0.335^2 - 0.335 \cdot 0.223 + \frac{0.223^2}{3} \right)} = 154 \text{ mA}$$

If we take the maximum  $R_{\text{ds(on)}}$  for a 125°C junction temperature, i.e. 24 Ω, then conduction losses worse case are:

$$P_{\text{cond}} = I_{\text{d,rms}}^2 R_{\text{DS(on)}} = 570 \text{ mW}$$

7. Off–time and on–time switching losses can be estimated based on the following calculations:

$$P_{\text{off}} = \frac{I_{\text{peak}}(V_{\text{bulk}} + V_{\text{clamp}})t_{\text{off}}}{2T_{\text{sw}}} = \frac{0.335 \times (127 + 120 \cdot 2) \times 10\text{n}}{2 \times 15.4\mu} = 36 \text{ mW} \quad (\text{eq. 7})$$

Where, assume the  $V_{clamp}$  is equal to two times of reflected voltage.

$$P_{on} = \frac{I_{valley}(V_{bulk} + N(V_{out} + V_f))t_{on}}{6T_{sw}} \quad (eq. 8)$$

$$= \frac{0.111 \times (127 + 100) \times 20n}{6 \times 15.4\mu}$$

$$= 5.5 \text{ mW}$$

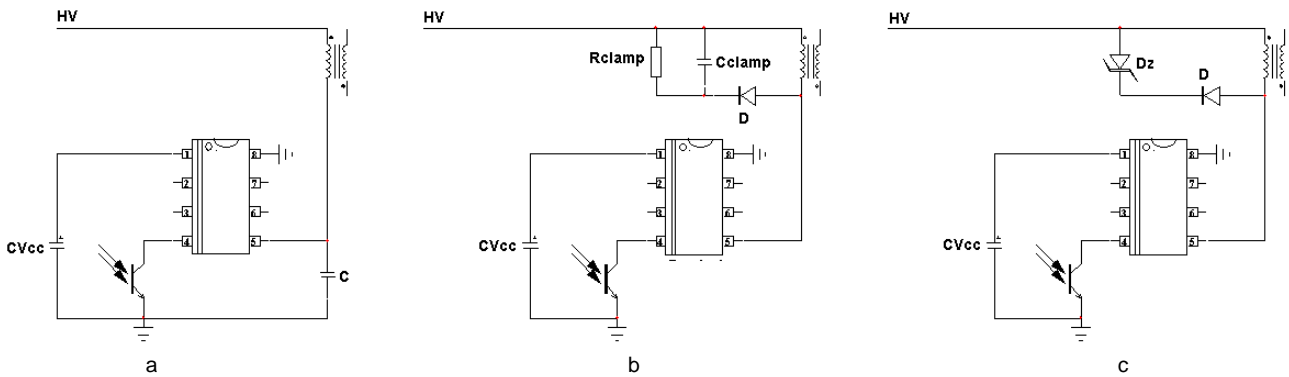
It is noted that the overlap of voltage and current seen on MOSFET during turning on and off duration is dependent on the snubber and parasitic capacitance seen from drain pin. Therefore the  $t_{off}$  and  $t_{on}$  in Equations 7 and 8 have to be modified after measuring on the bench.

8. The theoretical total power is then  $0.570 + 0.036 + 0.0055 = 611 \text{ mW}$
9. If the NCP107X operates at DSS mode, then the losses caused by DSS mode should be counted as losses of this device on the following calculation:

$$P_{DSS} = I_{CC1} \cdot V_{in,max} = 1m \cdot 375 = 375 \text{ mW} \quad (eq. 9)$$

**MOSFET protection**

As in any Flyback design, it is important to limit the drain excursion to a safe value, e.g. below the MOSFET BV<sub>DSS</sub> which is 700 V. Figure 40a, b, c present possible implementations:



**Figure 40. Different Options to Clamp the Leakage Spike**

Figure 40a: the simple capacitor limits the voltage according to The lateral MOSFET body–diode shall never be forward biased, either during start–up (because of a large leakage inductance) or in normal operation as shown by Figure 38. This condition sets the maximum voltage that can be reflected during  $t_{off}$ . As a result, the Flyback voltage which is reflected on the drain at the switch opening cannot be larger than the input voltage. When selecting components, you thus must adopt a turn ratio which adheres to the following equation: Equation 3. This option is only valid for low power applications, e.g. below 5 W, otherwise chances exist to destroy the MOSFET. After evaluating the leakage inductance, you can compute C with Equation 4. Typical values are between 100 pF and up to 470 pF. Large capacitors increase capacitive losses...

Figure 40b: the most standard circuitry is called the RCD network. You calculate  $R_{clamp}$  and  $C_{clamp}$  using the following formulae:

$$R_{clamp} = \frac{2 V_{clamp}(V_{clamp} - (V_{out} + V_f)N)}{L_{leak}I_{peak}^2 F_{sw}} \quad (eq. 10)$$

$$C_{clamp} = \frac{V_{clamp}}{V_{ripple} F_{sw} R_{clamp}} \quad (eq. 11)$$

$V_{clamp}$  is usually selected 50–80 V above the reflected value  $N \times (V_{out} + V_f)$ . The diode needs to be a fast one and a MUR160 represents a good choice. One major drawback of the RCD network lies in its dependency upon the peak current. Worse case occurs when  $I_{peak}$  and  $V_{in}$  are maximum and  $V_{out}$  is close to reach the steady–state value.

Figure 40c: this option is probably the most expensive of all three but it offers the best protection degree. If you need a very precise clamping level, you must implement a zener diode or a TVS. There are little technology differences behind a standard zener diode and a TVS. However, the die area is far bigger for a transient suppressor than that of zener. A 5 W zener diode like the 1N5388B will accept 180 W peak power if it lasts less than 8.3 ms. If the peak current in the worse case (e.g. when the PWM circuit maximum current limit works) multiplied by the nominal zener voltage exceeds these 180 W, then the diode will be destroyed when the supply experiences overloads. A transient suppressor like the P6KE200 still dissipates 5 W of continuous power but is able to accept surges up to 600 W @ 1 ms. Select the zener or TVS clamping level between 40 to 80 V above the reflected output voltage when the supply is heavily loaded.

## NCP1070, NCP1071, NCP1072, NCP1075, NCP1076, NCP1077

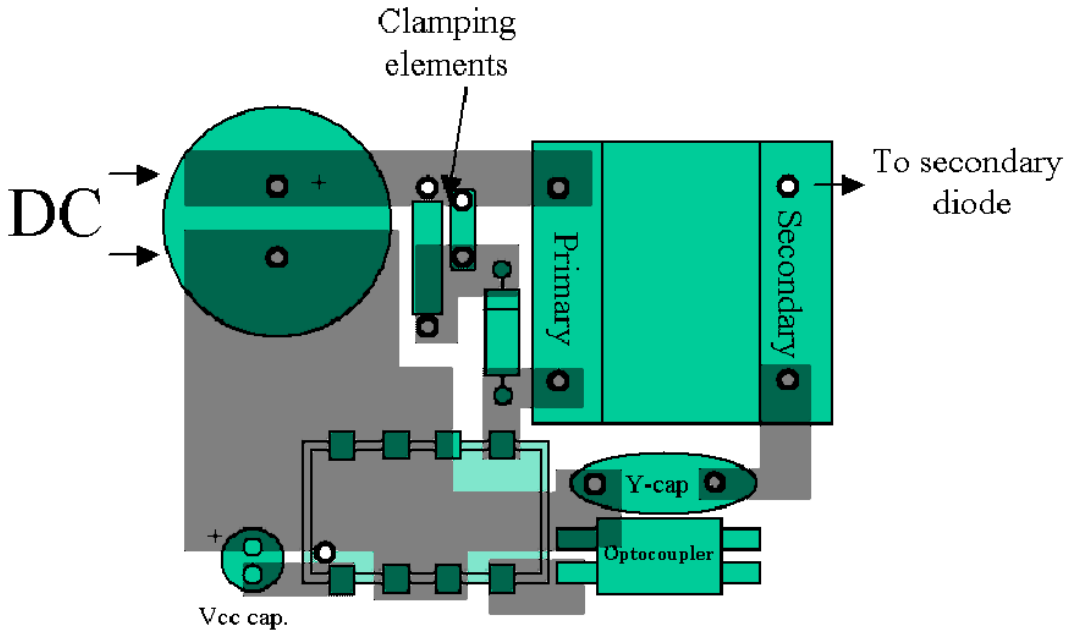
### Power Dissipation and Heatsinking

The NCP107X welcomes two dissipating terms, the DSS current–source (when active) and the MOSFET. Thus,  $P_{tot} = P_{DSS} + P_{MOSFET}$ . It is mandatory to properly manage the heat generated by losses. If no precaution is taken, risks exist to trigger the internal thermal shutdown (TSD). To help dissipating the heat, the PCB designer must foresee large copper areas around the package. Take the PDIP–7 package as an example, when surrounded by a surface greater than  $1.0 \text{ cm}^2$  of  $35 \text{ }\mu\text{m}$  copper, it becomes possible to drop its thermal resistance junction–to–ambient,  $R_{\theta JA}$  down to

$75^\circ\text{C/W}$  and thus dissipate more power. The maximum power the device can thus evacuate is:

$$P_{max} = \frac{T_{Jmax} - T_{ambmax}}{R_{\theta JA}} \quad (\text{eq. 12})$$

which gives around 930 mW for an ambient of  $50^\circ\text{C}$  and a maximum junction of  $120^\circ\text{C}$ . If the surface is not large enough, assuming the  $R_{\theta JA}$  is  $100^\circ\text{C/W}$ , then the maximum power the device can evacuate becomes 700 mW. Figure 41 gives a possible layout to help drop the thermal resistance.



**Figure 41. A Possible PCB Arrangement to Reduce the Thermal Resistance Junction–to–Ambient**

### A 10 W NCP1075 based Flyback Converter Featuring Low Standby Power

Figure 43 depicts a typical application showing a NCP1075–65 kHz operating in a 10 W converter. To leave more room for the MOSFET, it is recommended to disable the DSS by shorting the J3. In this application, the feedback

is made via a NCP431 whose low bias current ( $50 \text{ }\mu\text{A}$ ) helps to lower the no load standby power.

Measurements have been taken from a demonstration board implementing the diagram in Figure 43 and the following results were achieved with auxiliary winding to bias the device:

	100 Vac	115 Vac	230 Vac	265 Vac
No load consumption with auxiliary winding	26 mW	28 mW	38 mW	45 mW

NCP1070, NCP1071, NCP1072, NCP1075, NCP1076, NCP1077

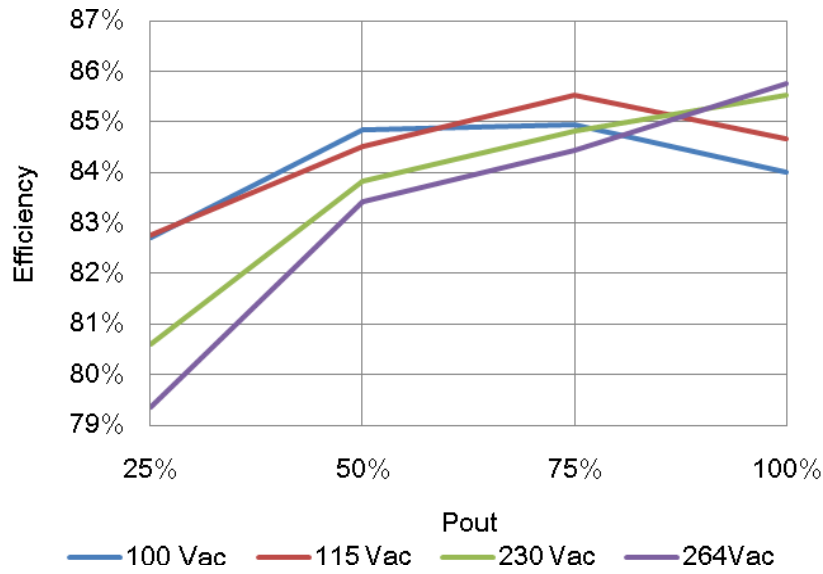


Figure 42.  $V_{out} = 12\text{ V}$

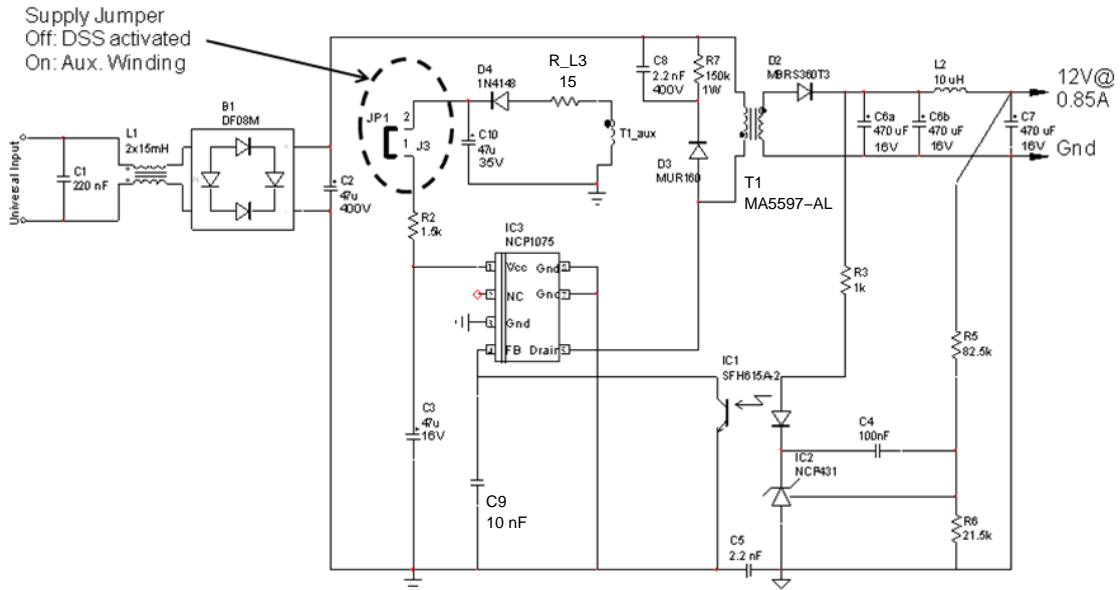


Figure 43. A 12 V – 0.85 A Universal Mains Power Supply

# NCP1070, NCP1071, NCP1072, NCP1075, NCP1076, NCP1077

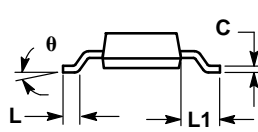
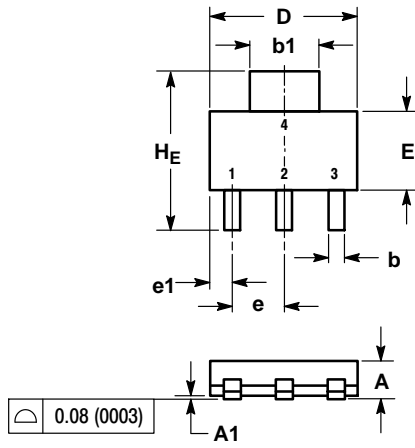
## ORDERING INFORMATION

Device	Frequency	R <sub>DS(on)</sub> (Ω)	I <sub>pk</sub> (mA)	Package Type	Shipping†
NCP1070STAT3G	65 kHz	22	250	SOT-223 (Pb-Free)	4000 / Tape & Reel
NCP1070STBT3G	100 kHz	22	250		4000 / Tape & Reel
NCP1070STCT3G	130 kHz	22	250		4000 / Tape & Reel
NCP1070P065G	65 kHz	22	250	PDIP-7 (Pb-Free)	50 Units / Rail
NCP1070P100G	100 kHz	22	250		50 Units / Rail
NCP1070P130G	130 kHz	22	250		50 Units / Rail
NCP1071STAT3G	65 kHz	22	350	SOT-223 (Pb-Free)	4000 / Tape & Reel
NCP1071STBT3G	100 kHz	22	350		4000 / Tape & Reel
NCP1071STCT3G	130 kHz	22	350		4000 / Tape & Reel
NCP1071P065G	65 kHz	22	350	PDIP-7 (Pb-Free)	50 Units / Rail
NCP1071P100G	100 kHz	22	350		50 Units / Rail
NCP1071P130G	130 kHz	22	350		50 Units / Rail
NCP1072STAT3G	65 kHz	11	250	SOT-223 (Pb-Free)	4000 / Tape & Reel
NCP1072STBT3G	100 kHz	11	250		4000 / Tape & Reel
NCP1072P065G	65 kHz	11	250		50 Units / Rail
NCP1072P100G	100 kHz	11	250	PDIP-7 (Pb-Free)	50 Units / Rail
NCP1072P100BG	100 kHz	11	250		50 Units / Rail
NCP1075STAT3G	65 kHz	11	450		SOT-223 (Pb-Free)
NCP1075STBT3G	100 kHz	11	450	4000 / Tape & Reel	
NCP1075STCT3G	130 kHz	11	450	4000 / Tape & Reel	
NCP1075P065G	65 kHz	11	450	PDIP-7 (Pb-Free)	50 Units / Rail
NCP1075P100G	100 kHz	11	450		50 Units / Rail
NCP1075P130G	130 kHz	11	450		50 Units / Rail
NCP1076STAT3G	65 kHz	4.7	650	SOT-223 (Pb-Free)	4000 / Tape & Reel
NCP1076STBT3G	100 kHz	4.7	650		4000 / Tape & Reel
NCP1076STCT3G	130 kHz	4.7	650		4000 / Tape & Reel
NCP1076P065G	65 kHz	4.7	650	PDIP-7 (Pb-Free)	50 Units / Rail
NCP1076P100G	100 kHz	4.7	650		50 Units / Rail
NCP1076P130G	130 kHz	4.7	650		50 Units / Rail
NCP1077STAT3G	65 kHz	4.7	800	SOT-223 (Pb-Free)	4000 / Tape & Reel
NCP1077STBT3G	100 kHz	4.7	800		4000 / Tape & Reel
NCP1077STCT3G	130 kHz	4.7	800		4000 / Tape & Reel
NCP1077P065G	65 kHz	4.7	800	PDIP-7 (Pb-Free)	50 Units / Rail
NCP1077P100G	100 kHz	4.7	800		50 Units / Rail
NCP1077P130G	130 kHz	4.7	800		50 Units / Rail

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS

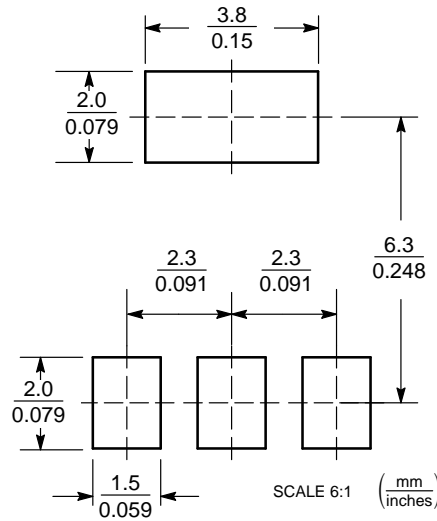
SOT-223 (TO-261)  
CASE 318E-04  
ISSUE N



NOTES:  
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.  
2. CONTROLLING DIMENSION: INCH.

DIM	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	1.50	1.63	1.75	0.060	0.064	0.068
A1	0.02	0.06	0.10	0.001	0.002	0.004
b	0.60	0.75	0.89	0.024	0.030	0.035
b1	2.90	3.06	3.20	0.115	0.121	0.126
c	0.24	0.29	0.35	0.009	0.012	0.014
D	6.30	6.50	6.70	0.249	0.256	0.263
E	3.30	3.50	3.70	0.130	0.138	0.145
e	2.20	2.30	2.40	0.087	0.091	0.094
e1	0.85	0.94	1.05	0.033	0.037	0.041
L	0.20	---	---	0.008	---	---
L1	1.50	1.75	2.00	0.060	0.069	0.078
HE	6.70	7.00	7.30	0.264	0.276	0.287
θ	0°	—	10°	0°	—	10°

SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.